Overview

Important Note: Features and Supported Configurations will differ between the Z4 G4 Workstations with Intel® Xeon®W Processors and the Z4 G4 Workstation with Intel® Core™ X Processors. Where different – features are shown side by side. Supported configurations are indicated by the CPU Support references.

HP Z4 G4 Workstation



Front view

- 1. Front I/O module options
 - Premium (optional): power button, 2 USB 3.1 G1 Type-A, 2 USB 3.1 G2 Type-C™, Headset audio, SD Card Reader (optional) (Left-most Type-A port has charging capability)
 - Standard (shown here): power button, 4 USB 3.1 G1 Type-A (left-most Type-A port has charging capability), Headset audio, SD Card Reader (optional)
- 2. Front handle
- 3. 2 x 5.25" external drive bays



Overview





Internal view

Intel® Xeon® W Processors

- 4. Intel® Xeon® Processors: W-2100 family
- 5. 2 PCle G3 x16, 2 PCle G3 x4, 1 PCle G3 x8
- 6. 2 PCIe G3 x4 M.2 for SSDs
- 7. 8 DIMM slots; DDR4-2666 ECC Registered RAM
- 8. PSU options:
 - 465W 90% efficient with 0 graphics power adapters
 - 750W 90% efficient with 2 graphics power adapters
 - 1000W 90% efficient with up to 4 graphics power Adapters

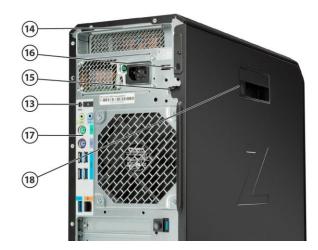
Intel® Core™ X-series Processors

- Intel[®] Core [™] i7-X-series processors Intel[®] Core [™] i9-X Series processors Intel[®] Core [™] i9 Extreme Edition processor
- 5. Core i9-X configs/Core i7 9800X: 2 PCIe G3 x16, 2 PCIe G3 x4, 1 PCIe G3 x8
 Other Core i7-X configs: 1 PCIe G3 x16, 1 PCIe G3 x16 (x8 electrical), 2 PCIe G3 x4, 1 PCIe G3 x8 (mechanical only)
- 6. 1 PCle G3 x4 M.2 for SSDs
- 7. 8 DIMM slots: DDR4-2666 Non-ECC Unbuffered RAM
- 8. PSU:
 - 1000W 90% efficient with up to 4 graphics power Adapters
- 2 x 5.25" external drive bays
 2 x 2.5"/3.5" internal drive bays
 Front card guide and fan (select configurations)
 6 x 6Gb/s SATA ports



Overview





Intel® Xeon® W Processors

Intel® Core™ X-series Processors

13. 14. 15. 16. 17. Rear I/O (top to bottom):

Audio in/out,

- Keyboard/Mouse PS/2
- USB: 6 USB 3.1 G1 Type-A
- 2x 1GbE ports

Rear power button Rear handle Padlock loop Kensington lock slot

- 17. Rear I/O (top to bottom):
 - Audio in/out,
 - Keyboard/Mouse PS/2 USB: 5 USB 3.1 G1 Type-A
 - 1x 1GbE port

Side panel barrel keylock (optional) 18.

Supported Components

Overview

Form Factor Operating Systems

Minitower

Intel® Xeon® W Processors

Preinstalled:

- Windows 11 Pro for Workstations**
- Windows 10 Pro for Workstations*,**
- Ubuntu 20.04 LTS
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat® Enterprise Linux® Desktop Workstation (Paper license with 1-year support; no preinstalled OS)

Tested and Documented:

- Red Hat® Enterprise Linux® Workstation 6, 7, 8
- SUSE Linux® Enterprise Desktop 12, 15
- Ubuntu 16.04, 18.04, 20.04 LTS

Intel® Core™ X-series Processors

Preinstalled:

- Windows 11 Pro**
- Windows 10 Pro*,**
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat® Enterprise Linux® Desktop Workstation (Paper license with 1-year support; no preinstalled OS)

Tested and Documented:

- Red Hat[®] Enterprise Linux[®] Workstation 6, 7.8
- SUSE Linux[®] Enterprise Desktop 12, 15
- Ubuntu 16.04, 18.04, 20.04 LTS

Notes: For detailed Linux® OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

* Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

**Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

*Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply, and additional requirements may apply over time for updates.

Note: In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel® and AMD 7th Generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com



Supported Components

Available Processors

Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MT/s)	ECC memory support	Max memory support	Hyper- Threading	Featuring Intel® vPro™ Technology	Intel® Turbo Boost Technology 2.0 (GHz) ¹	Intel® Turbo Boost Max Technology 3.0 (GHz) ²	TDP (W)
				Intel® Xed	on® W Proc	essors				
18	3.0	24.75	2933	YES	512GB	YES	YES	3.8, 4.6	4.8	168
14	3.3	19.25	2933	YES	512GB	YES	YES	4.1, 4.6	4.8	165
12	3.5	19.25	2933	YES	512GB	YES	YES	4.3, 4.6	4.8	165
10	3.7	19.25	2933	YES	512GB	YES	YES	4.3, 4.5	4.7	165
8	3.9	16.5	2933	YES	512GB	YES	YES	4.5, 4.5	4.7	155
6	3.8	8.25	2933	YES	512GB	YES	YES	4.3, 4.6	N/A	130
4	4.1	8.25	2933	YES	512GB	YES	YES	4.5, 4.6	N/A	105
4	3.6	8.25	2666	YES	512GB	YES	YES	3.7, 3.9	N/A	120
			Inte	el® Core™	X-Series P	rocessors				
18	3.0	24.75	2933	NO	256GB	YES	NO	3.8, 4.6	4.8	165
14	3.3	19.25	2933	NO	256GB	YES	NO	4.1, 4.6	4.8	165
12	3.5	19.25	2933	NO	256GB	YES	NO	4.3, 4.6	4.8	165
10	3.7	19.25	2933	NO	256GB	YES	NO	4.3, 4.5	4.7	165
	18 14 12 10 8 6 4 4 18 14 12	Cores Speed (GHz) 18 3.0 14 3.3 12 3.5 10 3.7 8 3.9 6 3.8 4 4.1 4 3.6 18 3.0 14 3.3 12 3.5	Cores Speed (GHz) Cache (MB) 18 3.0 24.75 14 3.3 19.25 12 3.5 19.25 10 3.7 19.25 8 3.9 16.5 6 3.8 8.25 4 4.1 8.25 4 3.6 8.25 18 3.0 24.75 14 3.3 19.25 12 3.5 19.25	Cores Speed (GHz) Cache (MB) Speed (MT/s) 18 3.0 24.75 2933 14 3.3 19.25 2933 12 3.5 19.25 2933 10 3.7 19.25 2933 8 3.9 16.5 2933 6 3.8 8.25 2933 4 4.1 8.25 2933 4 3.6 8.25 2666 Int 18 3.0 24.75 2933 14 3.3 19.25 2933 12 3.5 19.25 2933	Cores Speed (GHz) Cache (MB) Speed (MT/s) memory support 18 3.0 24.75 2933 YES 14 3.3 19.25 2933 YES 12 3.5 19.25 2933 YES 10 3.7 19.25 2933 YES 8 3.9 16.5 2933 YES 6 3.8 8.25 2933 YES 4 4.1 8.25 2933 YES 4 3.6 8.25 2666 YES Intel® Core™ 18 3.0 24.75 2933 NO 14 3.3 19.25 2933 NO 12 3.5 19.25 2933 NO	Cores Speed (GHz) Cache (MB) Speed (MT/s) memory support memory support Intel® Xeon® W Proc 18 3.0 24.75 2933 YES 512GB 14 3.3 19.25 2933 YES 512GB 12 3.5 19.25 2933 YES 512GB 10 3.7 19.25 2933 YES 512GB 8 3.9 16.5 2933 YES 512GB 6 3.8 8.25 2933 YES 512GB 4 4.1 8.25 2933 YES 512GB 4 3.6 8.25 2933 YES 512GB Intel® Core™ X-Series P 18 3.0 24.75 2933 NO 256GB 14 3.3 19.25 2933 NO 256GB 12 3.5 19.25 2933 NO 256GB	Cores (Hz) Speed (Hz) Cache (MB) Speed (MT/s) memory support support Hyper-Threading Intel® Xeon® W Processors 18 3.0 24.75 2933 YES 512GB YES 14 3.3 19.25 2933 YES 512GB YES 12 3.5 19.25 2933 YES 512GB YES 10 3.7 19.25 2933 YES 512GB YES 8 3.9 16.5 2933 YES 512GB YES 6 3.8 8.25 2933 YES 512GB YES 4 4.1 8.25 2933 YES 512GB YES 4 3.6 8.25 2666 YES 512GB YES Intel® Core™ X-Series Processors 18 3.0 24.75 2933 NO 256GB YES 14 3.3 19.25 2933 NO 256GB YES	Cores Clock Speed (GHz) Cache (MB) Speed (MT/s) ECC memory support Max memory support Hyper-Threading vPro™ Threading Intel® vPro™ Technology 18 3.0 24.75 2933 YES 512GB YES YES 14 3.3 19.25 2933 YES 512GB YES YES 12 3.5 19.25 2933 YES 512GB YES YES 10 3.7 19.25 2933 YES 512GB YES YES 8 3.9 16.5 2933 YES 512GB YES YES 6 3.8 8.25 2933 YES 512GB YES YES 4 4.1 8.25 2933 YES 512GB YES YES 4 3.6 8.25 2666 YES 512GB YES YES 4 3.6 8.25 2666 YES 512GB YES NO Intel	Cores Clock Speed (GHz) Cache (MB) EECC Speed (MT/s) Max memory support Hyper-Threading wPro™ support Intel® xeon® W Processors 18 3.0 24.75 2933 YES 512GB YES YES 3.8, 4.6 14 3.3 19.25 2933 YES 512GB YES YES 4.1, 4.6 12 3.5 19.25 2933 YES 512GB YES YES 4.3, 4.6 10 3.7 19.25 2933 YES 512GB YES YES 4.3, 4.6 8 3.9 16.5 2933 YES 512GB YES YES 4.5, 4.5 6 3.8 8.25 2933 YES 512GB YES YES 4.3, 4.6 4 4.1 8.25 2933 YES 512GB YES YES 4.5, 4.6 4 3.6 8.25 2666 YES 512GB YES YES 3.7, 3.9 Intel® Core™ X-S	Cores Clock Speed (GHz) Cache (MB) Memory support s

¹For Intel [®] Xeon[®] W processors, the specifications shown in this column represent the following: all core maximum turbo frequency, dual core maximum turbo frequency).

For Intel® Core™ processors, the specifications shown in this column refer to dual core maximum turbo frequency.

²Intel Turbo Boost Max Technology 3.0 identifies the best performing core(s) on a processor and provides increased performance on those cores by taking advantage of power and thermal headroom. Intel® Turbo Boost Max Technology 3.0 frequency is the clock frequency of the CPU when running in this mode.

NOTE: Processors that do not have certain turbo functionality are denoted as N/A.

Available Processors

Disclaimers

Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

Color Black **Convertibility** No



Supported Components

Expansion Slots (see more details)

Intel® Xeon® W Processors

Intel® Core™ X-series Processors

system board section for Slot 0: Mechanical-only, for use with devices that require only rear bulkhead mounting

Slot 1: PCI Express Gen3 x16 (from CPU)

Slot 2: PCI Express Gen3 x4 (from PCH) with open-ended connector*

PCI Express Gen3 x16 (from CPU) Core i9-X and Core i7-9800X configs: PCI Express

Gen3 x16 (from CPU)

Other Core i7-X configs: PCI Express Gen3 x16(mechanical) x8(electrical) (from CPU)

Slot 4: PCI Express Gen3 x4 (from PCH) with open-ended connector*

Slot 5: Slot 5:

PCI Express Gen3 x8 (from CPU) with open-ended connector*

- Core i9-X and Core i7-9800X configs: PCI Express Gen3 x8 (from CPU) with open-ended connector*

- Other Core i7-X configs: PCI Express Gen3 x8 (mechanical-only, no data) with open-ended

Intel® Core™ X- Series Processor Family

M.2 Slot 1: M.2 PCIe Gen 3 x4 (from CPU) up to 80mm storage devices

M.2 Slot 2: M.2 Slot 2:

M.2 PCIe Gen 3 x4 (from CPU) up to 80mm storage No 2nd M.2 connector/slot available devices

* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.

2 internal 3.5" bays (with acoustic dampening drive carriers pre-installed). Optional 2.5" adapter

Expansion Bays (see storage section for more available. details)

2 external 5.25" bays

- 3rd and 4th 3.5" HDD each occupy one external bay
- 3rd and 4th 2.5" HDD/SSD occupy a single external bay within a 2:1 carrier

Front I/O

- Base: Power button with power/fault LED, 1 Headset audio port, 4 USB 3.1 G1 Type A (1 charging, provides 1.5A at 5V)
- Premium (optional): Power button with power/fault LED, Drive activity LED, 1 Headset audio port, 2 USB 3.1 G1 Type-A (1 charging, provides 1.5A at 5V), 2 USB 3.1 G2 Type-C™ (each provides 3A at 5V)
- Optional: SD reader

Internal I/O

1 USB 3.1 G1 single-port header, 1 USB 2.0 single-port header and 1 USB 2.0 dual-port header

Rear I/O Intel® Xeon® W Processor Family

6x USB 3.1 G1 Type-A* 5x USB 3.1 G1 Type-A 2x 1GbE LAN ports (1x supporting Intel AMT) 1x 1GbE LAN ports

Audio: 1 Line out, 1 Line in (Line in can be retasked as microphone), 1 PS/2 mouse port, 1 PS/2

keyboard port, 1 Rear power button

Optional: 1 serial port (cable up to rear bulkhead), 2 Thunderbolt 3**

*All rear I/O motherboard USB-A ports are 0.9A at 5V

**HP's add-in Thunderbolt card provides two USB-C ports which provide 3A at 5V each

Interfaces Supported

SD card reader (optional)

6-channel SATA interface (6 @ 6.0 Gb/s)

6 channels are eSATA configurable for use with eSATA CTO/AMO Kit (No hot plug / hot swap

supported)



Supported Components

Thunderbolt 3 (optional)

USB 2.0, USB 3.1 G1 (aka USB 3.0), USB 3.1 G2 (optional)

On-board RAID Support SATA RAID 0 Striped Array Configuration

SATA RAID 1 Mirrored Array Configuration SATA RAID 5 Striped/Parity Configuration SATA RAID 10 Striped/Mirrored Configuration

Chassis Dimensions (H x

W x D)

H: 15.2" (386mm) W: 6.65" (169mm) D: 17.5" (445mm)

Packaged Dimensions H: 2

H: 22.5" (572mm) W: 12.4" (314mm) D: 22.2" (563mm)

Palletization Profile

6 units x 3 layers = 18 units per pallet 1200x1000x1836mm (pallet included)

Rack Dimensions

4U

Weight

Exact weights depend upon configuration (System weight only).

Minimum: 10.2 kg (22.4 lbs.) Standard: 11.3 kg (24.9 lbs.) Maximum: 17.3 kg (38.2 lbs.)

Temperature

Non-operating: -40° to 60° C (-40° to 140° F)

Operating: 5° to 35° C (40° to 95° F)

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F)

for every 305 m (1,000 feet) increase in elevation

Maximum rate of change: 10 °C/hr No direct sustained sunlight

Humidity

Operating: 10% to 85% relative humidity, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% relative humidity, non-condensing, 35° C maximum wet bulb

Maximum Altitude (non-

pressurized)

Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 feet)

Maximum operating temperature is reduced as altitude increases. See Temperature for details.

Power Supply

Processor Support

XW ENTRY

465 watts wide-ranging, active Power Factor Correction, 90% Efficient, with no 6-pin

graphics power cables.

The Z4 G4 465W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP%20INC_DPS-465AB-

3%20A_465W_ECOS%204939_Report.pdf

XW MID_RANGE

750 watts wide-ranging, active Power Factor Correction, 90% Efficient, with 2x 6-pin

graphics power cables.

The Z4 G4 750W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP%20INC_DPS-750AB-

36%20A_750W_ECOS%204938_Report.pdf

HIGH-END

XW, 1000 watts wide-ranging, active Power Factor Correction, 90% Efficient.

CX (i9) Includes 4x 6+2-pin graphics power cables: also includes a Front Fan and Card Guide kit to

enable support for dual high end graphics solutions.



Supported Components

CX (i7)

1000 watts wide-ranging, active Power Factor Correction, 90% Efficient. Includes 2x 6+2-pin graphics power cables.

The Z4 G4 1000W power supply efficiency report can be found at this link:

https://plugloadsolutions.com/psu_reports/HP_D15-1K0P1A_1000W_ECOS%204838_Report.pdf

NOTE: 1000 W internal power supply, up to 90% efficiency, active PFC available the first half of 2018

Workstation ISV Certifications

See the latest list of certifications at

http://www8.hp.com/us/en/campaigns/workstations/industries-and-partners.html



Supported Components

Processors		Factory Configure d	Option Kit	Option Kit Part Number	Support Notes
	Intel® Xeon® W-Series CPU				
	Intel® Xeon® W-2295 3.0 2933 18C CPU	Υ	N		
	Intel® Xeon® W-2275 3.3 2933 14C CPU	Υ	N		
	Intel® Xeon® W-2265 3.5 2933 12C CPU	Υ	N		
	Intel® Xeon® W-2255 3.7 2933 10C CPU	Υ	N		
	Intel® Xeon® W-2245 3.9 2933 8C CPU	Υ	N		
	Intel® Xeon® W-2235 3.8 2933 6C CPU	Υ	N		
	Intel® Xeon® W-2225 4.1 2933 4C CPU	Υ	N		
	Intel® Xeon® W-2223 3.6 2933 4C CPU	Υ	N		
	Intel® Xeon® W-2145 3.7 2666 8C CPU	Υ	N		
	Intel® Xeon® W-2133 3.6 2666 6C CPU	Υ	N		
	Intel® Core™ X-Series CPU				
	Intel® Core™ i9-10980XE 3.0 2933 18C CPU	Υ	N		
	Intel® Core™ i9-10940X 3.3 2933 14C CPU	Υ	N		
	Intel® Core™ i9-10920X 3.5 293312C CPU	Υ	N		
	Intel® Core™ i9-10900X 3.7 2933 10C CPU	Υ	N		
	Intel® Core™ i7-9800X 3.8 2666 8C CPU	Υ	N		

Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

Monitors / Displays		Processor Supports	Factory Configure d	Option Kit	Option Kit Part Number	Support Notes
	HP Z Display Z22n G2	XW, CX		Υ	1JS05AA	
	HP Z Display Z23n G2	XW, CX		Υ	1JS06AA	
	HP Z Display Z24i G2	XW, CX		Υ	1JS08AA	
	HP Z Display Z24n G2	XW, CX		Υ	1JS09AA	
	HP Z Display Z24nf G2	XW, CX		Υ	1JS07AA	
	HP Z Display Z27n G2	XW, CX		Υ	1JS10AA	
	HP Z Display Z27s (4K display)	XW, CX		Υ	J3G07AA	
	Supported by all operating systems a Screen size measured diagonally	vailable from HP				

Storage / Hard Drives*



Supported Components

SAS Hard Drives		Factory		Option		
		Processor	Configure	Option	Kit Part	Support
	SAS Hard Drives for HP Workstations	Supports	d	Kit	Number	Notes
	HP 300GB 15k SAS SFF	XW	Υ	Υ	L5B74AA	

NOTE: Only available on Xeon W configs SAS controller add-in card required

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity may be less. Up to 32GB (for Windows 10) is reserved for system recovery software.

SATA Hard Drives		Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SATA (Serial ATA) Hard Drives for HP Workstations					
	500GB SATA 7200RPM 6Gb/s 3.5" HDD	XW, CX	Υ	Υ	LQ036AA	
	500GB SATA 7200RPM 6Gb/s 0PAL2 SFF 3.5" HDD	XW, CX	Υ	Υ	D8N29AA	
	1TB SATA 7200RPM 3.5" HDD	XW, CX	Υ	Υ	LQ037AA	
	1TB SATA 7200RPM Ent 3.5" HDD	XW, CX	Υ	Υ	WOR10AA	
	2TB SATA 7200RPM 3.5" CMR HDD	XW, CX	Υ	Υ	QB576AA	
	2TB SATA 7200RPM 3.5" SMR HDD	XW, CX	Υ	Υ	8VE04AA/AT	
	2TB 7200RPM SATA 3.5in Enterprise		Υ	Υ	2Z274AA	
	4TB SATA 7200RPM Ent 3.5" HDD	XW, CX	Υ	Υ	K4T76AA	
	6TB SATA 7200RPM Ent 3.3" HDD	XW, CX	Υ	Υ	3DH90AA	
	8TB 7200RPM SATA 3.5in Enterprise		Υ	Υ	2Z273AA	
	NOTES:Up to (4) 3.5-inch 7200 rpm SATA driv	es: 500 GB, 1	1.0, 2.0, 4.0, 1	6TB max	total	

SATA Solid State Drives		Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Solid State Drives (SSDs) for Workstations					
	HP 256GB SATA SSD	XW, CX	Υ	Υ	A3D26AA/AT	
	HP 512GB SATA SSD	XW, CX	Υ	Υ	D8F30AA	
	HP 1TB SATA SSD	XW, CX	Υ	Υ	F3C96AA/AT	
	HP 2TB SATA SSD	XW, CX	Υ	Υ	Y6P08AA/AT	
	HP 256GB SATA SED OPAL2 SSD	XW, CX	Υ	Υ	G7U67AA	
	HP 512GB SATA SED OPAL2 SSD	XW, CX	Υ	Υ	N8T26AA	
	HP 240GB SATA Enterprise SSD	XW, CX	Υ	Υ	T3U07AA	
	HP 480GB SATA Enterprise SSD	XW, CX	Υ	Υ	T3U08AA	
	HP 960GB 2.5in Enterprise SATA-3 SSD		Υ	Υ	1W6P8AA	
	1920GB 2.5in Enterprise SATA-3 SSD		Υ	Υ	1W6P9AA	



Ontion

QuickSpecs

Supported Components

PCle	Soli	d
State	• Dri	VPS

				Option	
	Processor Supports	Factory Configured	Option Kit	Kit Part Number	Support Notes
PCIe SSDs for HP Workstations	••	•			
HP Z Turbo Drive 256GB MLC Z4/Z6 G4 SSD Kit	XW, CX	N	N	EOL	
HP Z Turbo Drive 512GB MLC Z4/Z6 G4 SSD Kit	XW, CX	N	N	EOL	
HP Z Turbo Drive 1TB MLC Z4/Z6 G4 SSD Kit	XW, CX	N	N	EOL	
HP Z Turbo Drive 256GB TLC Z4/Z6 G4 SSD Kit	XW, CX	Υ	Υ	1PD59AA/AT	
HP Z Turbo Drive 512GB TLC Z4/Z6 G4 SSD Kit	XW, CX	Υ	Υ	1PD60AA	
HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SSD Kit	XW, CX	Υ	Υ	1PD61AA	
HP Z Turbo Drive 2TB TLC Z4/Z6 G4 SSD Kit	XW, CX	Υ	Υ	3KP39AA	
HP Z Turbo Drive 256GB Z4/Z6 G4 SED Kit	XW, CX	Υ	Υ	4YZ41AA	
HP Z Turbo Drive 512GB Z4/Z6 G4 SED Kit	XW, CX	Υ	Υ	4YZ44AA/AT	
HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Kit	XW, CX	Υ	Υ	6YT76AA	
HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Module	XW, CX	Υ	Υ	6YT79AA	2
HP Z Turbo 2TB SED OPAL2 TLC M.2 Z4/Z6 SSD	XW, CX	Υ	Υ	2Y7W6AA	
HP 256GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit	XW, CX	Υ	Υ	8PE68AA	
HP 512GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit	XW, CX	Υ	Υ	8PE69AA	
HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit	XW, CX	Υ	Υ	8PE70AA	
HP 256GB M.2 2280 PCIe NVMe TLC SSD Module	XW, CX	N	Υ	8PE62AA	2
HP 512GB M.2 2280 PCIe NVMe TLC SSD Module	XW, CX	N	Υ	8PE63AA	2
HP 1TB M.2 2280 PCIe NVMe TLC SSD Module	XW, CX	N	Υ	8PE64AA	2
HP 2TB PCIe NVME TLC M.2 Z4/6 G4 SSD	XW, CX	Υ	Υ	35F74AA	
HP Z Turbo Drive Quad Pro					
HP Z Turbo Drive Quad Pro 2x256GB TLC PCIe® SSD	XW, CX (i9)	Υ	Υ	4YZ38AA	1, 3
HP Z Turbo Drive Quad Pro 2x512GB TLC PCIe® SSD	XW, CX (i9)	Υ	Υ	4YZ39AA/AT	1, 3
HP Z Turbo Drive Quad Pro 2x1TB TLC PCIe® SSD	XW, CX (i9)	Υ	Υ	4YZ40AA	1, 3
HP Z Turbo Drive Quad Pro 2x2TB PCIe® SSD	XW, CX (i9	Υ	Υ	3KP42AA	
HP Z Turbo Drive Quad Pro 256GB TLC SSD module	XW, CX (i9)	N	Υ	4YZ35AA	1, 2, 3
HP Z Turbo Drive Quad Pro 512GB TLC SSD module	XW, CX (i9)	N	Υ	4YZ36AA/AT	1, 2, 3
HP Z Turbo Drive Quad Pro 1TB TLC SSD module	XW, CX (i9)	N	Υ	4YZ37AA	1, 2, 3
HP Z Turbo Drive Quad Pro 2TB TLC SSD module	XW, CX (i9	N	Υ	3KP43AA	2
HP Z Turbo Drive Dual Pro					
HP Z Turbo Drive Dual Pro 256GB TLC SSD		Υ	Υ	4YF60AA	
HP Z Turbo Drive Dual Pro 512GB TLC SSD		Υ	Υ	4YF61AA	
HP Z Turbo Drive Dual Pro 1TB TLC SSD		Υ	Υ	4YF62AA	
HP Z Turbo Drive Dual Pro 2TB TLC SSD		Υ	Υ	4YF63AA	
HP 256GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	XW, CX	Υ	Υ	8PE74AA	
HP 512GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	XW, CX	Υ	Υ	8PE75AA	
HP 1TB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	XW, CX	Υ	Υ	8PE76AA	
Intel® 905p Series SSD (Opatane SSD)					
Intel® Optane SSD 905p 280GB AiC**		Υ	Υ	2SC47AA	
Intel® Optane SSD 905p 480GB AiC**		Υ	Υ	2SC48AA	

Supported Components

Intel® Optane SSD 905P 380GB M.2 PCIe Dual	Υ	Υ	6LA63AA	1
Intel® Optane SSD 905P 2x380GB M.2 PCIe Quad	Υ	Υ	6LA65AA	1
Intel® Optane SSD 905P 380GB M.2 SSD Module	Υ	Υ	6LA66AA	2.3

Note 1: All HP Z Turbo Drive Quad Pro modules require the Z4 G4 Fan & Front Card Kit, available as CTO (1MY89AV) and AMO (1XM33AA)

Note 2: M.2 SSD module only, designed to be installed into the Z Turbo Drive Quad Pro or Dual Pro carrier **Note 3:** Z Turbo Drive Quad Pro is not supported on Core i7-X configurations

^{**} PCIe card installed in standard PCIe x4 slot

Intel® Virtual RAID on CPU (Intel® VROC) for NVMe		Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Intel® VROC NVMe SSD Standard Controller Module		N	Υ	3FJ80AA	1,3
	Intel® VROC NVMe SSD Premium Controller Module		N	Υ	3FJ81AA	2,3

NOTE 1: Enables RAID 0, 1 & 10

NOTE 2: Enables RAID 0, 1 & 10 plus RAID 5 with write hole closure options.

NOTE 3: Xeon processor required

Hard Drive				Option Kit			
Controllers		Processor Supports	Factory Configured	Option Kit	Part Number	Support Notes	
	SAS Controller						
	MicroSemi SmartHBA2100-4i4e SAS Controller	XW	Υ	Υ	1FV90AA		
	NOTE: Only available on Xeon W configurations						

Graphics

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported # of cards
Graphics Cable Adapters						
HP DisplayPort to HDMI Adapter	XW, CX	Υ	Υ	K2K92AA		
HP DisplayPort to Dual Link DVI Adapter	XW, CX	Υ	Υ	NR078AA		
HP DisplayPort to DVI-D Adapter	XW, CX	Υ	Υ	FH973AA		
HP DisplayPort to DVI-D Adapter (2-pack)	XW, CX	Υ	N			
HP DisplayPort to DVI-D Adapter (4-pack)	XW, CX	Υ	N			
HP DisplayPort to DVI-D Adapter (6-pack)	XW, CX	Υ	N			
HP miniDP-to-DP Adapter	XW, CX	Υ	Υ	2MY05AA		
HP miniDP-to-DP Adapter (2-pack)	XW, CX	Υ	N			
HP miniDP-to-DP Adapter (4-pack)	XW, CX	Υ	N			
HP miniDP-to-DP Adapter (8-pack)	XW, CX	Υ	N			
Graphics Card Connectors						
NVIDIA® SLI 2-slot Graphics Connector	XW, CX	Υ	Y	2YY84AA		



Supported Components

Quadro® RTX NVLink 2-slot Bridge (RTX 5000)	XW, CX	N	Υ	6FY12AA		
Quadro® RTX NVLink High-Bandwidth 2-slot Bridge (RTX 6000 & 8000)	XW, CX	N	Υ	6FY11AA		
NVIDIA NVLink 2-Slot Bridge (RTX A6000, RTX A5000)		N	Υ	340L2AA		2
Entry 3D						
NVIDIA® Quadro® P620 2GB Graphics	XW, CX	Υ	Υ	3ME25AA	4	2
NVIDIA® T400 2GB Graphics	XW, CX	Υ	Υ	340K8AA	4	2
NVIDIA® T600 4GB Graphics	XW, CX	Υ	Υ	340K9AA	4	2
Mid-range 3D						
NVIDIA® Quadro® P1000 4GB Graphics	XW, CX	Υ	Υ	1ME01AA	3, 4	2
AMD Radeon™ RX 6700 XT 12GB Graphics	XW, CX	Υ	N		2	
AMD Radeon™ Pro WX 3100 4GB Graphics	XW, CX	Υ	Υ	2TF08AA	3, 4	2
AMD Radeon™ Pro WX 3200 4GB Graphics	XW, CX	Υ	Υ	6YT68AA	3, 4	2
AMD Radeon™ Pro WX 4100 4GB Graphics	XW, CX	N	Υ	ZOB15AA	3, 4	2
NVIDIA® T1000 4GB Graphics	XW, CX	Υ	Υ	20X22AA	3.4	2
NVIDIA® RTX A2000 6GB Graphics	XW, CX	Υ	Υ	340L0AA	3, 4	2
NVIDIA® RTX A2000 12GB Graphics	XW, CX	Υ	Υ	5Z7D9AA	3, 4	2
High-End 3D						
NVIDIA® Quadro® P4000 8GB Graphics	XW, CX	Υ	Υ	1ME40AA	1, 2, 5	2
NVIDIA® Quadro® RTX 4000 8GB Graphics	XW, CX	Υ	Υ	5JV89AA	1, 2	2
NVIDIA® RTX A4000 16GB 4DP Graphics	XW, CX	Υ	Υ	20X24AA/AT	1, 2	2
NVIDIA® RTX A4500 20GB Graphics	XW, CX	Υ	Υ	5S458AA/AT	1, 2, 5	2
AMD Radeon™ Pro W5500 8GB Graphics	XW, CX	Υ	Υ	9GC16AA	1, 2	2
AMD Radeon™ Pro W5700 8GB Graphics	XW, CX	Υ	Υ	9GC15AA/AT	1, 2, 5	2
AMD Radeon™ Pro W6800 32GB Graphics	XW, CX	Υ	Υ	340K7AA	1, 2, 5	2
AMD Radeon™ Pro WX 7100 8GB Graphics	XW, CX	Υ	Υ	ZOB14AA	1, 2	2
Ultra High-End 3D						
NVIDIA® Quadro® GP100 16GB Graphics	XW, CX	N		1ZE81AA	1, 2, 5	2
NVIDIA® Quadro® GV100 32GB Graphics	XW, CX	Υ		3ME26AA	1, 2, 5	2
NVIDIA® Quadro® P5000 16GB Graphics	XW, CX	Υ	Υ	ZOB13AA	1, 2, 5	2
NVIDIA® Quadro® P6000 24GB Graphics	XW, CX	Υ	Υ	Z0B12AA	1, 2, 5	2
NVIDIA® Quadro® RTX 5000 16GB Graphics	XW, CX	Υ	Υ	5JH81AA	1, 2	2
NVIDIA® Quadro® RTX 6000 24GB Graphics	XW, CX	Υ	Υ	5JH80AA	1, 2	2
NVIDIA® Quadro® RTX 8000 48 GB Graphics	XW, CX	Υ	Υ	6NB51AA	1, 2	2
NVIDIA® RTX A5000 24 GB Graphics	XW, CX	Υ	Υ	20X23AA	1,2,5	2
NVIDIA® RTX A6000 48GB Graphics	XW, CW	Υ	Υ	2S6U3AA	1,2,5	2
AMD Radeon™ Pro WX 9100 16GB Graphics	XW, CX	Υ		2TF01AA	1, 2	1
NVIDIA® Quadro® Sync II	XW, CX	N	Υ	1WT20AA		

NOTE 1: Single graphics configuration requires the HP Z4 G4 Fan and Front Card Guide Kit, which is available both CTO (1MY89AV) and AMO (1XM33AA).

NOTE 2: Single graphics configuration requires the 750W chassis or 1000W chassis.



Supported Components

NOTE 3: Dual graphics configuration requires the HP Z4 G4 Fan and Front Card Guide Kit, which is available both CTO (1MY89AV) and AMO (1XM33AA).

NOTE 4: Dual graphics configuration requires the 750W chassis or 1000W chassis.

NOTE 5: Dual graphics configuration requires the 1000W chassis.

Factory Memory Supp SL CL Option **Option Kit Processor** Configur ort **Processor Processor Supports** Kit **Part Number Notes** ed Υ HP 8GB (1x8GB) DDR4-2666 ECC Reg RAM Υ Ν XW Υ 1XD84AA/AT 1 16GB (1x16GB) DDR4-2666 ECC Reg RAM Υ Ν XW Υ Υ 1XD85AA/AT 1 32GB (1x32GB) DDR4-2666 ECC Reg RAM Υ N XW Υ Υ 1,2 1XD86AA/AT HP 8GB (1x8GB) DDR4-2933 ECC Reg RAM XW Υ Υ Υ Υ 5YZ56AA/AT 1,3 16GB (1x16GB) DDR4- 2933 ECC Reg RAM Υ XW Υ Υ 5YZ54AA/AT 1.3 Ν 32GB (1x32GB) DDR4- 2933 ECC Reg RAM Ν Υ XW Υ Υ 5YZ55AA / AT 1,2,3 Υ Υ Υ 64GB (1x64GB) DDR4- 2933 ECC Reg RAM Ν XW 5YZ57AA / AT 1,3,4 Υ Υ HP 8GB (1x8GB) DDR4-2933 nECC RAM Υ CX Υ 7ZZ64AA /AT 1,3,5 HP 16GB (1x16GB) DDR4-2933 nECC RAM Ν Υ CX Υ Υ 7ZZ65AA / AT 1.3.5 HP 32GB (1x32GB) DDR4-2933 nECC RAM Υ Υ Υ N CX 7ZZ66AA/AT 1,3,4

SL Processor: Are processors formerly known as as Intel® Skylake that are sold under the model name Intel® Xeon® W-2100 Family or Intel® Core™ i7X, Core™ i9-7900X/XE, and Core™ i9-9000X/XE family

CL Processor: Are processors formerly known as Cascade Lake that are in model name Intel® Xeon® W-2200 family or Intel® Core™ i9-10900X/XE family

NOTES

1: ONLY DDR4 DIMMs are supported.

2: Memory configurations using Xeon Skylake (W-21xx) processors and 32GB Registered DIMMs require the HP Z4 Memory Cooling Solution, which is available both CTO (1MY90AV) and AMO (8TC68AA). Memory configurations using Xeon Cascade Lake and 32GB Registered DIMMs do not require the Memory Cooling Solution.

3: Intel® Core™ i9-10900X/XE and Intel® Xeon® W-2200 family processors only support 2933 speed memory. **4:**

- 32GB nECC Memory is only available with Intel® Core™ i9-10900X/XE family processors.
- 64GB Registered Memory is only available with Intel® Xeon® W-2200 family processors.

5: Discontinued Core i7X, Core i9-7900X/XE, and Core i9-9000X/XE family processors are only compatible with Memory Option Kit 7ZZ64AA/AT 8GB (1x8GB) DDR4 2933 NECC UDIMM Memory

Option Kit 7ZZ65AA/AT 16GB (1x16GB) DDR4 2933 NECC UDIMM Memory has transitioned to newer 16Gbit DRAM and is incompatible with these discontinued Core X processors.

NOTE: Factory-configured CTO (xxxxxAV) and aftermarket AMO (xxxxxAA, xxxxxAT) HP memory part numbers designated as "2666" may ship with "2933" or "3200" speed memory components. Similarly, HP Memory part numbers designated as "2933" may ship with "3200" speed memory. This does not affect HP part number availability, nor does it affect system performance or operation. All hardware configurations currently supporting HP memory part numbers designated as "2666" or 2933 have been fully qualified to work with fast speed memory and are fully supported by HP under standard support terms.



Supported Components

Factory Configured System Memory Solutions	Available with Intel Xeon Processor & Registered Memory	Available with Intel Core X Processor & nECC Memory
8GB (1x8GB) DDR4	Yes	Yes
16GB (1x16GB) DDR4	Yes	Yes
16GB (2x8GB) DDR4	Yes	Yes
24GB (3x8GB) DDR4	Yes	Yes
32GB (2x16GB) DDR4	Yes	Yes
32GB (4x8GB) DDR4	Yes	Yes
64GB (2x32GB) DDR4	Yes	Yes (Note 1)
64GB (4x16GB) DDR4	Yes	Yes
64GB (8x8GB) DDR4	Yes	Yes
128GB (2x64GB) DDR4	Yes (Note 2)	No
128GB (4x32GB) DDR4	Yes	Yes (Note 1)
128GB (8x16GB) DDR4	Yes	Yes
192GB (6x32GB) DDR4	Yes	Yes (Note 1)
256GB (4x64GB) DDR4	Yes (Note 2)	No
256GB (8x32GB) DDR4	Yes	Yes (Note 1)
384GB (6x64GB) DDR4	Yes (Note 2)	No
512GB (8x64GB) DDR4	Yes (Note 2)	No

NOTE 1: 32GB nECC Memory Configurations are only available with Intel® Core™ i9-10900X/XE family processors.

NOTE 2: 64GB Registered Memory Configurations are only available with Intel® Xeon® W-2200 family processors.

Supported Components

Multimedia and Audio Devices

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated Realtek HD ALC221 Audio	XW, CX	Υ	N		

Optical and Removable Storage

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP SlimTray Optical Drives					
HP 9.5mm Slim Blu Ray Disc Writer	XW, CX	Υ	Υ	K3R65AA	1
HP 9.5mm Slim DVD ROM	XW, CX	Υ	Υ	K3R63AA	1
HP 9.5mm Slim DVD Writer*	XW, CX	Υ	Υ	K3R64AA	1
HP HH DVD Writer (16x RW DVD-R)	XW, CX	Υ	Υ	4AR67AA	
HP SD Card Reader					
HP SD 4 Card Reader	XW, CX	Υ	Υ	2VK54AA	
NVMe Frame/Carrier					
HP QX310 Removable NVMe Frame/Carrier w/PCIe card	XW, CX	Υ	N		
HP QX310 Removable Carrier only	XW, CX	N	Υ	8GQ91AA/AT	2

NOTE 1: Installing an optical drive into Z4 G4 requires a 5.25" external bay adapter (Option Kit Part number NQ099A).

NOTE 2: Only approved HP Z Turbo storage devices are supported.

*Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Networking and Communications

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Intel® i350-T2 PCIe Dual Port Gigabit NIC	XW, CX	Υ	Υ	V4A91AA	
Intel® i350-T4 PCIe 4-Port Gigabit NIC	XW, CX	N	Υ	W8X25AA	
Intel® Ethernet I210-T1 PCIe x1 Gb NIC	XW, CX	Υ	Υ	E0X95AA	
Aquantia® AQN-108 Single-Port 5GbE NIC	XW, CX	N	Υ	1PM63AA	
Intel® X550-T2 10GbE Dual Port NIC	XW, CX	Υ	Υ	1QL46AA	
Intel® X710-DA2 10GbE SFP+ Dual Port NIC	XW, CX	Υ	Υ	1QL47AA	1



Supported Components

HP 10GbE SFP+ SR Transceiver	XW, CX	Υ	Υ	C3N53AA
Intel 8265 802.11 a/b/g/n/ac + BT PCIe WLAN	XW, CX	N	Υ	1QL48AA
Intel® Wi-Fi 6 AX200 & BT PCIe	XW, CX	N	Υ	7CE01AA
Intel AX210 Wi-Fi 6e non-vPro +Bluetooth 5.2 External Antenna WLAN	XW, CX	N	Y	340L7AA
Allied Telesis AT-2914SX/LC-901 1GB LC Fiber I Note 1: Windows 7 is NOT supported	NIC	Y	Y	1C7Q2AA

Racking and Physical Security



Supported Components

Racking and Physical Security

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	
HP Z4/Z6 Side Panel Barrel Keylock	XW, CX	Υ	N			
HP Solenoid Lock / Hood Sensor	XW, CX	Υ	N			
HP Z4/Z6 G4 Depth Adjustable Fixed Rail Rack Kit	XW, CX	N	Υ	2HW42AA		
HP Z2 Mini/Z2 TWR/Z4/Z6 Depth Adj Rail Rak Kit			Υ	2A8Y5AA		
HP Keyed Cable Lock 10mm	XW, CX	N	Υ	T1A62AA		
HP Master Keyed Cable Lock 10mm	XW, CX	N	Υ	T1A63AA		

Input Devices

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Wireless Business Slim Keyboard and Mouse	XW, CX	Υ	Υ	N3R88AA	
Business Slim PS/2 Wired Keyboard	XW, CX	Υ	Υ	N3R86AA	
USB Business Slim Wired Keyboard	XW, CX	Υ	Υ	N3R87AA	
USB Premium Wired Keyboard	XW, CX	Υ	Υ	Z9N40AA/AT	
USB Wired SmartCard CCID Keyboard	XW, CX	Υ	Υ	E6D77AA	
HP Optical USB Mouse	XW, CX	Υ	Υ	QY777AA/AT	
HP PS/2 Mouse	XW, CX	Υ	Υ	QY775AA/AT	
HP USB Hardened Mouse	XW, CX	Υ	Υ	P1N77AA/AT	
HP Creator 935 Black Wireless Mouse	XW, CX	N	Υ	1D0K8AA	
HP Wired 320M Mouse	XW, CX	Υ	Υ	9VA80AA	

Other Hardware

				Option Kit	
	Processor Supports	Factory Configured	Option Kit	Part Number	Support Notes
HP ENERGY STAR® Certified Configuration	XW, CX	Υ			
HP Z Premium Front I/O 2xUSB-A 2xUSB-C	XW, CX	Υ	Υ	1XM32AA	
HP Thunderbolt 3 PCIe 2 Port I/O Card	XW, CX	Υ	Υ	3UU05AA	
HP Z4 G4 Memory Cooling Solution	XW, CX	Υ	Υ	8TC68AA	Note 1
HP Z4 G4 Fan and Front Card Guide Kit	XW, CX	Υ	Υ	1XM33AA	Note 2
HP Internal USB Port Kit	XW, CX	N	Υ	EM165AA	Note 3
HP eSATA 2 port PCIe Bulkhead Kit	XW, CX	Υ	Υ	GM110AA	
HP Serial Port Adapter	XW, CX	Υ	Υ	PA716A	
HP Workstation Mouse Pad	XW, CX	Υ			

Note 1: The HP Z4 G4 Memory Cooling Solution is available to add to any configuration for improved system cooling, but is required for memory configurations using Xeon Processors and 32GB Registered DIMMs.



Supported Components

Note 2: Fan and Front Card Guide required with the following components:

- Specific graphics configurations (see Graphics section above)
- Any HP Z Turbo Quad Pro configuration

Note 3: The HP Internal USB Port kit has a single USB 2.0 type A connector.

Application Software

	Processor Supports	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Sobey Video Editing SW	XW, CX	Υ	N		China only
ZCentral Remote Boost	XW, CX	N	N		
Data Science Stack	XW, CX	Υ	N		1, 2
WSL2/Ubuntu Data Science Stack	XW, CX	Υ	N		1,3

*Not all Application Software for Z Desktop Workstations is included with purchase.

Note 1: Only available with NVIDIA graphics cards selections. Available on products equipped with Intel® 7th generation processors.

Note 2: Only available with Ubuntu 20.04 LTS preinstall.

Note 3: Only available with Windows 10 Pro/Pro for Workstations or Windows 11 Pro/Pro for

Workstations.



Supported Components

Operating Systems		Processor Supports	Support Notes
Window	s 11 Pro for Workstations	XW	Note 1,5,6
Window	s 11 Pro	CX	Note 5,6
Window	s 10 Pro for Workstations	XW	Note 1,4,5,6
Window	s 10 Pro	CX	Note 4,5,6
Ubuntu 2	20.04 LTS	XW	Note 2
HP Linux	< [®] Ready	XW, CX	Note 2
Red Hat	® Enterprise Linux® (RHEL) Workstation - Paper License (1yr)	XW, CX	Note 2,3

NOTE 1: Only applicable to Xeon W configurations.

NOTE 2: For detailed Linux® OS/hardware support information, see:

http://www.hp.com/support/linux_hardware_matrix

NOTE 3: This second OS must be ordered with the HP Linux® Installer Kit as the first OS.

NOTE 4: Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

NOTE 5: Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

NOTE 6: Available with Windows Subsystem for Linux® (WSL 2).



System Technical Specifications

System Board

System Board Form Main System Board: **Factor** 27.7 x 28.0 cm 10.9 x 11.0 inches

Processor Socket Single LGA2066 R4

Chipset Intel® Xeon® W Processor Family Intel® Core™ X-series Processors

Intel® C422 Chipset Intel® X299 chipset

Nuvoton NPCD315HA0DX (SIO-15) Super I/O Controller **Memory Expansion** 8 DDR4 memory slots Slots

Memory Type

DDR4, RDIMM (Registered), ECC DDR4, UDIMM, non-ECC Supported

Memory Modes Channel Interleaved **Memory Speed** 2933MT/s, 2666MT/s, 2400MT/s, and 2133MT/s

Supported

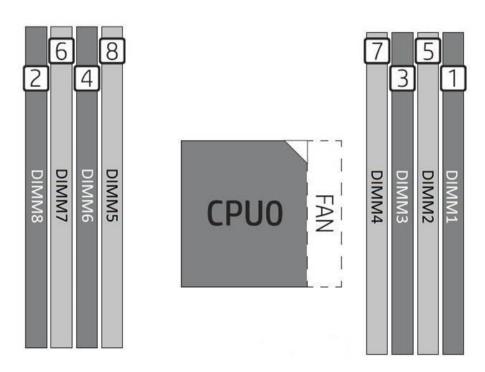
N/A **Memory Protection** ECC available on data, parity on address and command

Supports up to 512GB **Maximum Memory** Supports up to 256GB

Memory Configuration (Supported) **Memory Load Order**

Only Registered DIMMs are supported.

Only non-ECC unbuffered DIMMs are supported



Note on Maximum Memory

Maximum memory capacities assume 64-bit operating systems such as Windows 10 Pro.



System Technical Specifications

For systems installed with Microsoft Windows 7 (Ultimate, Enterprise or Pro), the maximum accessible system memory is 192GB

PCI Express Connectors

Intel® Xeon® W Processor Family

Intel® Core™ X-series Processors

Slot 1 (top): PCI Express Gen3 x16 supplied by CPU.

Slot 2 (PCH): PCI Express Gen3 x4 supplied by PCH with open-ended connector. **

Slot 3: Slot 3:

PCI Express Gen3 x16 supplied by CPU

Core i9-X and Core i7-9800X configs: PCI Express Gen3 x16 supplied by CPU

Core i7-X configs: PCI Express Gen3 x16 (mechanical)/ x8 (electrical)supplied by CPU

Slot 4 (PCH): PCI Express Gen3 x4 supplied by PCH with open-ended connector**

Slot 5:

Slot 5:

PCI Express Gen3 x8 supplied by CPU with openended connector**

- Core i9-X and Core i7-9800X configs: PCI Express Gen3 x8 supplied by CPU with openended connector**
- Other Core i7-X configs: PCI Express Gen3 x8 (mechanical-only, no data) with open-ended connector**

NOTE: Slots 1 through 5 support full-height, full-length cards (with extender)

M.2 Slot 1: PCI Express Gen3 x4 supplied by CPU

Socket Type 3, Key M, H4.2, sizes 2260-D5-M, 2280-D5-M, 22110-D5-M

M.2 Slot 2:

M.2 Slot 2:

PCI Express Gen3 x4 supplied by CPU No 2nd M.2 connector/slot available Socket Type 3, Key M, H4.2, sizes 2260-D5-M,

2280-D5-M, 22110-D5-M

** Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.



System Technical Specifications

Supported Drive Interfaces **SATA**

6 SATA @ 6GB/s, supports RAID 0,1, 5, and 10

Factory integrated Intel® SATA RAID is Microsoft Windows only

Intel® Xeon® W Processor Family Intel® Core™ X-series Processors Serial Attached SCSI

Requires Optional PCIe card not supported

Factory Configured RAID RAID 0 striped array

 RAID 1 mirrored array • RAID 10 striped and mirrored array

*HW RAID functionality not supported by Linux®. Use SW RAID functionality provided in the Red Hat®

Operating system instead.

Integrated Graphics No

Network Controller Intel® Xeon® W Processor Family Intel® Core™ X-series Processors

Intel® I219-LM PCIe GbE LAN Intel® I219-V PCIe GbE LAN

Intel® I210-AT PCIe GbE LAN Supports the following management functionalities: WOL and PXE 2.1

Supports the following management functionalities:

Intel AMT11.1x, TXT, DASH 1.1, WOL, VLAN, Teaming and PXE 2.1

External SATA (eSATA) Supported on all SATA ports configurable with optional eSATA* cable kit

* hot plug / hot swap not supported with eSATA

IDE connector No

Floppy connector No

Serial 1 internal header

2nd Serial No Parallel No AUX IN (audio) No IEEE 1394 Connector(s)

Front None

None Rear

Internal None

USB Connector(s)

Front Front USB depends on which FIO module is selected:

- Standard: 4 USB 3.1 G1 Type A (1 charging)

- Premium: 2 USB 3.1 G2 Type C[™], 2 USB 3.1 G1 Type A (1 charging)

Rear Intel® Xeon® W Processor Family Intel® Core™ X-series Processors

> 6 USB 3.1 G1 Type A 5 USB 3.1 G1 Type-A

Internal 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header

1x USB 2.0 dual-port header



System Technical Specifications

HD Integrated Audio Realtek ALC221

Flash ROM Yes **CPU Fan Header** Yes **Rear Chassis Fan Header** Yes Front PCI Fan Header Yes Front Control Panel/Speaker Yes

Header

CMOS Battery Holder -Yes

Lithium

Integrated Trusted Platform Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670)

Module Common Criteria EAL4+ Certified

Yes

Yes

Convertible to FIPS 140-2 Certified mode through firmware v7.85

TPM Certified products list:

https://trustedcomputinggroup.org/membership/certification/tpm-certified-products/

Power Supply Headers Power Switch, Power LED &

Hard Drive LED Header

Clear Password Jumper Yes

Serial Port 1 internal header

Parallel Port No

Keyboard/Mouse USB or PS/2

Hood Lock Header Yes **Hood Sensor Header** Yes

1 Memory Fan Header **Memory Fan**

AUX IN (audio) No

Power Supply

750W 90% Efficient, Custom PSU 465W 90% Efficient, Custom PSU **Power Supply** (Wide-Ranging, Active PFC) (Wide-Ranging, Active PFC)

90-269 VAC 90-269 VAC **Operating Voltage Range** 100-240 VAC 118 VAC 100-240 VAC Rated Voltage Range

118 VAC 50-60 Hz 400 Hz 50-60 Hz 400 Hz **Rated Line Frequency**

Operating Line Frequency 47-66 Hz 393-407 Hz 47-66 Hz 393-407 Hz Range

100-240V @ 10A 100-240V @ 6A 118V @ 10A 118V @ 6A **Rated Input Current**

Heat Dissipation Typical = 1850 btu/hr Typical = 1147 btu/hr (Configuration and software Max = 3084 btu/hrMax = 1912 btu/hr dependent)

80x25 mm variable speed 80x25 mm variable speed **Power Supply Fan**

ENERGY STAR® Certified Yes Yes (Configuration dependent)

90% Efficient 90% Efficient

> The Z4 G4 750W power supply efficiency report The Z4 G4 465W power supply efficiency report

> > can be found at this link: can be found at this link:

https://plugloadsolutions.com/psu_reports/HP% https://plugloadsolutions.com/psu_reports/HP%

20INC DPS-750AB-20INC DPS-465AB-

36%20A 750W ECOS%204938 Report.pdf 3%20A 465W ECOS%204939 Report.pdf

80 PLUS® Compliant

System Technical Specifications

Power Supply 1000W 90% Efficient, Custom PSU (Wide-Ranging, Active PFC)

Operating Voltage Range 90–269 VAC

Rated Voltage Range100-127 VAC
200-240 VAC

118 VAC

Rated Line Frequency 50–60 Hz 400 Hz

Operating Line Frequency 47–66 Hz 393–407 Hz Range

12A @100-127 VAC

Rated Input Current 12A @ 118VAC 12A @ 118VAC

Heat Dissipation(Configuration and software

Typical = 2467 btu/hr

dependent) Max = 4112 btu/hr

Power Supply Fan 80x25 mm variable speed

ENERGY STAR® Certified Yes (Configuration dependent)

90% Efficient

80 PLUS® Compliant The Z4 G4 1000W power supply efficiency report can be found at this link:

https://plugloadsolutions.com/psu_reports/HP_D15-1K0P1A_1000W_ECOS%204838_Report.pdf

FEMP Standby Power
Compliant @115V Yes Yes Yes

<1W in S5 – Power Off)

EuP Compliant @ 230V Yes (<0.5 W in S5 – Power Off)

CECP Compliant @ 220V
Yes; Configuration dependent
Yes; Configuration dependent

(<4W in S3 – Suspend to RAM)
Power Consumption in sleep

mode

(as defined by ENERGY TBD TBD

STAR®) – Suspend to RAM

(Instantly Available PC)

Built-in Self Test LED Yes Yes
Surge Tolerant Full Ranging

Power Supply
Yes
Yes

(withstands power surges up to 2000V)

NOTE: 1000 W internal power supply, up to 90% efficiency, active PFC available the first half of 2018



System Technical Specifications

System Configuration

Example Z4 G4	Processor	1x Intel Xeon	1x Intel Xeon W-2102 4C 2.9GHz							
Workstation	Memory	1x 8GB DDR4	x 8GB DDR4-2666 (Registered DIMM)							
Configuration #1	Graphics	1x NVIDIA Qua	adro P400							
ENERGY STAR®	Disks / Optical	1x 500GB SAT	1x 500GB SATA 7200 ; 1x Slim DVD-ROM SATA							
Certified	Power Supply	465W 90% cu	stom PSU							
	Other	N/A	N/A							
		115	5 VAC	230	VAC	100	VAC			
Energy Consumption		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled			
	Windows Idle (S0)	42.323		41.338		42.585				
	Windows Busy Typ(S0)	TBD		TBD		TBD				
	Windows Busy Max (S0)	90	.231	92.	323	90.786				
	Sleep (S3)	3.449	3.440	3.566	3.558	3.530	3.410			
	Off (S5)	1.041	1.014	1.242	1.231	1.310	1.180			
	Zero Power Mode (ErP)	0.	187	0.	43	0.174				
		115	5 VAC	230	VAC	100 VAC				
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled			
(Btu/hr)	Windows Idle (S0)	144	1.406	141.045		145.301				
	Windows Busy Typ(S0)	Т	BD	TI	3D	TE	BD			
•	Windows Busy Max (S0)	307	7.868	315	.006	309	.761			
	Sleep (S3)	11.767	11.737	12.167	12.140	12.044	11.634			
	Off (S5)	3.551	3.459	4.237	4.200	4.469	4.026			
	Zero Power Mode (ErP)	0.	638	1.467 0.594			94			

Example Z4 G4	Processor	1x Intel Xeon	W-2123 4C 3.6	GHz				
Workstation	Memory	2x 8GB DDR4-2666 (Registered DIMM)						
Configuration #2	Graphics	1x NVIDIA QuadroP1000						
ENERGY STAR®	Disks / Optical	1x 500GB SAT	ΓΑ 7200 ; 1x Slii	m DVD-ROM S	ATA			
Certified	Power Supply	750W 90% cu	istom PSU					
certificu	Other	N/A						
Energy Consumption	ımption		5 VAC	230	230 VAC		VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	39.947		39.569		40.956		
	Windows Busy Typ(S0)	TBD		TBD		TBD		
	Windows Busy Max (S0)	149	9.543	150.789		147.845		
	Sleep (S3)	3.615	3.566	3.801	3.798	3.634	3.621	
	Off (S5)	1.079	1.016	1.440	1.238	1.320	1.170	
	Zero Power Mode (ErP)	0.	204	0.430		0.191		
		11:	5 VAC	230 VAC		100 VAC		
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	



System Technical Specifications

(Btu/hr) Windows Idle (S0)		136.299		135.009		139.741	
	Windows Busy Typ(S0)	TBD		TBD		TBD	
	Windows Busy Max (S0)	510.241		514.492		504.447	
	Sleep (S3)	12.338	12.167	12.969	12.959	12.399	12.355
	Off (S5)	3.681	3.466	4.913	4.224	4.504	3.992
	Zero Power Mode (ErP)	0.696		1.467		0.651	

Example Z4 G4	Processor	1x Intel Xeon W-2133 6C 3.6GHz							
Workstation	Memory	4x 8GB DDR4-2666 (Registered DIMM)							
Configuration #3	Graphics	1x NVIDIA QuadroP2000							
	Disks/Optical	2x 1TB SATA7	'200 ; 1x Slim S	uperMulti DVI	DRW SATA				
	Power Supply	750W 90% cu	stom PSU						
	Other	N/A							
Energy Consumption		115	VAC	230	VAC	100	VAC		
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	48	.759	46.	321	46.	578		
	Windows Busy Typ(S0)	TBD		199.56		206.055			
	Windows Busy Max (S0)	209.60		208.66		198.82			
	Sleep (S3)	4.360	4.351	4.538	4.508	4.299	4.277		
	Off (S5)	1.039	1.017	1.42	1.219	1.015	0.997		
	Zero Power Mode (ErP)	0.203		0.399		0.191			
		115 VAC		230 VAC		100 VAC			
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled		
(Btu/hr)	Windows Idle (S0)	166	5.366	258	.047	158	.924		
	Windows Busy Typ(S0)	Т	BD	TI	BD	TE	BD		
	Windows Busy Max (S0)	715	5.155	711	.947	678	.373		
	Sleep (S3)	14.876	14.845	15.483	15.381	14.668	14.593		
	Off (S5)	3.544	3.470	4.845	4.179	3.463	3.402		
	Zero Power Mode (ErP)	0.	692	1.3	361	0.6	551		

Example Z4 G4	Processor	1x Intel Xeon W-2155 10C 3.3GHz							
Workstation Configuration #4	Memory	8x 32GB DDR4-2666 (Registered DIMM)							
	Graphics	1x NVIDIA QuadroP6000							
	Disks / Optical	4x 2TB SATA 7200 ; 0x 0DD							
	Power Supply	750W 90% custom PSU							
	Other	N/A							
Energy Consumption		115	VAC	230 VAC		100	VAC		
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
	Windows Idle (S0)	65.9	959	69.321		68.635			
	Windows Busy Typ(S0)	ТВ	D	TBD		TBD			
	Windows Busy Max (S0)	463	.23	456.95		503.125			



System Technical Specifications

	Sleep (S3)	6.336	6.102	6.971	6.189	6.266	6.264	
	Off (S5)	1.047	1.036	1.254	1.222	1.014	0.995	
	Zero Power Mode (ErP)	0.2	03	0.3	99	0.1	91	
		115 VAC		230 VAC		100 VAC		
		115 VAC		230	230 VAC		TOU VAC	
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	
(Btu/hr)	Windows Idle (S0)	225.052		236.523		234.183		
	Windows Busy Typ(S0)	TBD		TBD		TBD		
	Windows Busy Max (S0)	1580.541		1559.113		1716.663		
	Sleep (S3)	21.618	20.821	23.785	21.117	21.379	21.372	
	Off (S5)	3.572	3.534	4.278	4.169	3.459	3.394	
	Zero Power Mode (ErP)	0.6	92	1.3	61	0.6	52	

Example Z4 G4	Processor	1x Intel Core i	7-7800X 3.50	Hz 6C						
Workstation	Memory	2x 8GB DDR4-	2666 (non-E0	CC DIMM)						
Configuration #5	Graphics	1x NVIDIA Qua	1x NVIDIA Quadro P1000							
	Disks / Optical	1x 1TB SATA 7	'200 : 1x Slim	DVD-ROM SA	ТА					
	Power Supply	1000W 90% c	ustom PSU							
	Other	N/A								
Energy Consumption		115	VAC	230	VAC	100	VAC			
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled			
	Windows Idle (S0)	46.9	909	47.	175	46.9	909			
	Windows Busy Typ(S0)	TBD		TBD		TBD				
	Windows Busy Max (S0)	201.83		199.97		203.41				
	Sleep (S3)	3.041	2.971	3.165	3.041	2.971	3.165			
	Off (S5)	0.978	0.898	1.159	0.978	0.898	1.159			
	Zero Power Mode (ErP)	0.1	99	0.379		0.187				
		115	VAC	230	VAC	100 VAC				
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled			
(Btu/hr)	Windows Idle (S0)	160.	053	160	.961	160.	053			
	Windows Busy Typ(S0)	ТВ	D	TE	3D	TE	BD			
	Windows Busy Max (S0)	688.	644	682	.297	694.	035			
	Sleep (S3)	10.376	10.137	10.799	10.376	10.137	10.799			
(Off (S5)	3.337	3.064	3.954	3.337	3.064	3.954			
	Zero Power Mode (ErP)	0.6	78	1.2	293	0.638				

Example Z4 G4	Processor	1x Intel Core i7-7920X 2.9GHz 12C
Workstation	Memory	4x 16GB DDR4-2666 (non-ECC DIMM)
Configuration #6 Graphics 1x NVIDIA Quadro P4000		1x NVIDIA Quadro P4000
	Disks / Optical	2x 2TB SATA 7200 : 1x Slim DVD-ROM SATA
	Power Supply	1000W 90% custom PSU

System Technical Specifications

	Other	N/A					
Energy Consumption		115	VAC	230 VAC		100 VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	53.3	392	51.	332	53.	367
•	Windows Busy Typ(S0)	ТВ	BD	TE	3D	TE	3D
	Windows Busy Max (S0)	318	.58	307	7.82	319).71
	Sleep (S3)	3.558	3.486	3.694	3.558	3.486	3.694
	Off (S5)	0.972	0.895	1.160	0.972	0.895	1.160
	Zero Power Mode (ErP)	0.201		0.391		0.186	
		115 VAC		230 VAC		100 VAC	
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
(Btu/hr)	Windows Idle (S0)	182.	174	175.144		182.088	
	Windows Busy Typ(S0)	TB	BD	TE	3D	TE	3D
	Windows Busy Max (S0)	1086	.994	1050).281	1090.851	
	Sleep (S3)	12.139	11.894	12.604	12.139	11.894	12.604
	Off (S5)	3.316	3.054	3.957	3.316	3.054	3.957
	Zero Power Mode (ErP)	0.6	85	1.3	334	0.634	

NOTE: Power consumption measurements do not take advantage of the Intel Turbo Boost Technology. As a result, power consumption measurements may be higher.

DECLARED NOISE EMISSIONS

Declared Noise Emissions (Entry-level and High-end configurations)				
System Configuration (Entry level)	Processor Info	Intel® Xeon® W-2125 4.0 2666 4C CPU		
	Memory Info	32GB (4x8GB) DDR4-2666 ECC Reg RAM		
	Graphics Info	1-NVIDIA® Quadro® P400 2GB		
	Disks/Optical	1-500GB SATA 7200RPM 3.5" HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer		
	Power Supply	465 W		

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.2	13
	Hard drive Operating (random reads)	3.4	15

System Configuration (High end)	Processor Info	Intel® Xeon® W-2155 3.3 2666 10C
	Memory Info	128GB (8x16GB) DDR4-2666 ECC Reg RAM
	Graphics Info	1-NVIDIA® Quadro® P6000 24GB
	Disks/Optical	2-4TB SATA 7200RPM Ent 3.5" / 1-HP 9.5mm Slim Blu Ray Disc Writer
	Power Supply	750 W

System Technical Specifications

Declared Noise Emission
(in accordance with ISO
7779 and ISO 9296)

	Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
Idle	3.5	22
Hard drive Operating (random reads)	3.7	23

	System Configuration
Ì	(Fntry eyel 2)

Processor Info	Intel® Core i9-7900X 3.3 2666 10C	
Memory Info	32GB (4x8GB) DDR4-2666 nECC RAM	
Graphics Info	1-NVIDIA® Quadro® P400 2GB	
Disks/Optical	1-500GB SATA 7200RPM Ent 3.5" / 1-HP 9.5mm Slim Blu Ray Disc Writer	
Power Supply 1000 W		

Declared Noise Emissions
(in accordance with ISO
7779 and ISO 9296)

	Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
Idle	3.4	16
Hard drive Operating (random reads)	3.5	17

System	Confi	gurat	ion
(Hiah er	nd 2)		

Processor Info	Intel®Core i9-7980XE 2.6 2666 18C 128GB (8x16GB) DDR4-2666 nECC RAM	
Memory Info		
Graphics Info	1-NVIDIA® Quadro® P6000 24GB	
Disks/Optical	2-4TB SATA 7200RPM Ent 3.5" / 1-HP 9.5mm Slim Blu Ray Disc Writer	
Power Supply	wer Supply 1000 W	

Declared Noise Emission
(in accordance with ISO
7779 and ISO 9296)

	Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
Idle	3.5	20
Hard drive Operating (random reads)	3.7	21

NOTE: Higher noise levels may be experienced with non-HP approved graphic card(s). Some consumer graphics cards have side blowing fans that may heat up thermal sensor(s) on the mother board causing fans to ramp.

ENVIRONMENTAL DATA

Environmental Requirements

Temperature Non-operating: -40° to 60° C (-40° to 140° F)

Operating: 5° to 35° C (40° to 95° F)

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation

Maximum rate of change: 10 °C/hr

No direct sustained sunlight

Humidity Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb



System Technical Specifications

Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb

Maximum Altitude Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)

Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 feet)

Maximum operating temperature is reduced as altitude increases. See

Temperature for details.

Shock (non-repetitive) Operating: 1/2-sine: 40g, 2-3ms (~62 cm/sec)

Non-operating: 1/2-sine: 160 cm/s, 2-3ms (~105g)

Non-operating square: 422 cm/s, 20g

Vibration Operating random: 0.5q (rms), 5-300 Hz, up to 0.0025q²/Hz

Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz

Physical Security and Serviceability

Access Panel Tool-less

Includes system board and memory information.

Hard Drives Tool-less **Expansion Cards** Tool-less **Processor Socket** Tool-less

Blue User Touch Points Yes, on primary serviceable components.

Color-coordinated Cables Yes

and Connectors

Memory Tool-less **System Board** Screw-In **Dual Color Power/Failure** Yes

LED

Screen

HDD Activity LED

Note: HDD Activity LED is not dual-color

Configuration Record SW Yes

Over-Temp Warning on

Yes, at POST screen on reboot

Restore CD/DVD Set

Dual Function Front

Restores the computer to its original factory shipping image; can be obtained via HP Support.

Power Switch

Yes, causes a fail-safe power off when held for 4 seconds

Padlock Support Yes (optional): Locks side cover and secures chassis from theft

7.0 mm (0.2756 in) diameter padlock loop at rear of system

Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft **Cable Lock Support**

3 mm x 7 mm slot at rear of system

Universal Chassis Clamp

Lock Support

Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows

multiple units to be chained together when used with optional cable

Threaded feature at rear of system Yes (optional)

Solenoid Lock and Hood

Sensor

The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through

software and a password. You can also lock and unlock the chassis remotely over the network. The

Sensor Kit detects when the access panel has been removed

System Technical Specifications

Serial, Parallel, USB. Audio. Network. Enable/Disable Port

Yes, enables or disables serial, USB, audio, and network ports

Control

Removable Media Write/Boot Control Yes, prevents ability to boot from removable media on supported devices (and can disable writes to

media)

Power-On Password

Yes, prevents an unauthorized person from booting up the workstation

Setup Password

Yes, prevents an unauthorized person from changing the workstation configuration

3.3V Aux Power LED on

System PCA

Yes

NIC LEDs (integrated) (Green & Amber)

Yes

CPUs and Heatsinks

A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be

removed. CPU removal is tool-less

Power Supply Diagnostic Yes

Front Power Button Yes, ACPI multi-function

Rear Power Button

Front Power LED

Yes, white (normal), red (fault)

Front Hard Drive Activity Yes, white

Front ODD Activity LED Yes, on device

Internal Speaker **System/Emergency ROM** Recovers corrupted system BIOS.

Yes

Flash Recovery

Air cooled forced convection heatsinks

Cooling Solutions Power Supply Fans

80 mm x 80 mm x 25 mm (non-serviceable)

CPU Heatsink Fan

Intel® Core™ X-series Processors Intel® Xeon® W Processor Family

CPU configs <= 140W: 92 mm x 92 mm x 25 mm, 5- CPU configs <= 140W: 92 mm x 92 mm x 25 mm, 5wire, PWM

wire, PWM

CPU configs > 140W: 92 mm x 92 mm x 25 mm, 6-CPU configs > 140W: 92 mm x 92 mm x 25 mm, 6wire, PWM (includes 6-to-5pin cable adapter)

wire, PWM (includes 6-to-5pin cable adapter)

Chassis Fan Front:

(Optional) 92 mm x 92mm x 25 mm, 4-wire, PWM

Rear:

120 mm x 120mm x 25 mm, 4-wire, PWM

Memory Heatsink Fan HP PC Hardware Diagnostics UEFI

Dual 60 mm x 60 mm x 25 mm, 6-wire, PWM, Blindmate (optional based on configuration)

HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing ESC then F2 upon the PC reboot, and is

available as a download from HP Support.

Access Panel Key Lock ACPI-Ready Hardware Yes, side panel barrel keylock (optional from the factory only) Advanced Configuration and Power Management Interface (ACPI).

Allows the system to wake from a low-power mode.



System Technical Specifications

Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system

Trusted Platform Module Infineon TPM 2.0 Certified

Chip

Integrated Chassis

Yes, Front handle and dedicated rear recess

Handles **Power Supply**

Requires T15 Torx or flat blade screwdriver

PCIe Card Retention

Yes, rear (all), middle (all), front (full-length cards with extender, using HP Z4 G4 Fan and Front Card

Guide Kit)

Flash ROM Yes **Diagnostic Power Switch** Yes

LED on board

Clear Password Jumper Yes **Clear CMOS Button** Yes CMOS Battery Holder Yes **DIMM Connectors** Yes

BIOS

BIOS 32-bit Services

Standard BIOS 32-bit Service Directory Proposal v0.4

PCI 3.0 Support

Full BIOS support for PCI Express through industry standard interfaces.

ATAPI

ATAPI Removable Media Device BIOS Specification Version 1.0.

BBS BIOS Boot Specification v1.01.

WMI Support

WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM)

and WBEM specifications.

BIOS Boot Spec 1.01+

Provides more control over how and from what devices the workstation will boot.

BIOS Power On

Users can define a specific date and time for the system to power on.

ROM Based Computer Setup Utility (F10)

Review and customize system configuration settings controlled by the BIOS.

System/Emergency ROM

Flash Recovery with

Video

Recovers system BIOS in corrupted Flash ROM.

Replicated Setup

Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). BiosConfigUtility.exe utility can then replicate these settings on machines being deployed without entering Computer

Configuration Utility (F10 Setup).

SMBIOS Boot Control System Management BIOS 2.8, for system management information. Disables the ability to boot from removable media on supported devices.

Memory Change Alert Thermal Alert

Alerts management console if memory is removed or changed. Monitors the temperature state within the chassis. Three modes:

• NORMAL - normal temperature ranges.

 ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.

• SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.

Remote ROM Flash

Provides secure, fail-safe ROM image management from a central network console. Allows the system to enter and resume from low power modes (sleep states).

ACPI (Advanced Configuration and Power Management Interface)

Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without

affecting other elements of the system.



System Technical Specifications

Supports ACPI 5.0 for full compatibility with 64-bit operating systems.

Ownership Tag A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.

Shutdown

Remote Wakeup/Remote System administrators can power on, restart, and power off a client computer from a remote location with Intel Xeon W Processors. For systems with Intel Core X-Series Processors, Wake on LAN is supported, however to remotely restart or shutdown a system, a remote desktop application must be used to manually Restart or Shutdown.

Instantly Available PC (Suspend to RAM - ACPI sleep state S3)

Allows for very low power consumption with quick resume time.

Remote System Installation via F12 (PXE operating system.

Allows a new or existing system to boot over the network and download software, including the

2.1) (Remote Boot from Server)

ROM revision levels

Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW

applications can use and report this information.

System board revision

Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.

Start-up Diagnostics (Power-on Self-Test)

level

Assesses system health at boot time with selectable levels of testing.

Auto Setup when new hardware installed

System automatically detects addition of new hardware.

Keyboard-less Operation The system can be booted without a keyboard.

Localized ROM Setup

Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with

local keyboard mappings.

The user or MIS to set a unique tag string in non-volatile memory. **Asset Tag**

Per-slot Control **Adaptive Cooling Pre-boot Diagnostics**

Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. Control parameters are set according to detected hardware configuration for optimal acoustics.

(Pre-video) critical errors are reported via beeps and blinks on the power LED.

Industry Standard Specification Support

Industry Standard Revision Supported by the BIOS

UEFI Specification

Revision

2.6

Advanced Configuration and Power Management Interface, Version 5.0 **ACPI** ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b **CD Boot** "El Torito" Bootable CD-ROM Format Specification Version 1.0

- Enhanced Disk Drive Specification Version 1.1 **EDD**

- BIOS Enhanced Disk Drive Specification Version 3.0

EHCI Enhanced Host Controller Interface for Universal Serial Bus. Revision 1.0

PCI Local Bus Specification, Revision 2.3 PCI

PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7 PCI Express Base Specification, Revision 2.0

PCI Express PCI Express Base Specification, Revision 3.0

POST Memory Manager Specification, Version 1.01

SATA Serial ATA Specification, Revision 1.0a

> Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0

SPD PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B

TPM Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670)



PMM

System Technical Specifications

Common Criteria EAL4+ Certified

FIPS 140-2 Certified

TCG TPM Certified products list:

http://www.trustedcomputinggroup.org/certification/tpm-certified-products/

UHCI Universal Host Controller Interface Design Guide, Revision 1.1

USB Universal Serial Bus Revision 1.1 Specification

Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 G1 Specification Universal Serial Bus Revision 3.1 G2 Specification

SMBIOS System Management BIOS Reference Specification, Version 2.8

External BIOS simulator found at: http://h20464.www2.hp.com/index.html

Social and Environmental Responsibility

Eco-Label Certifications & This product has received or is in the process of being certified to the following approvals and may be **Declarations** labeled with one or more of these marks:

- ENERGY STAR® (energy-saving features available on selected configurations-Windows only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program
- The ECO declaration (TED)
- TCO Certified configurations available*

*TCO Certified configurations available when ENERGY STAR configurations are selected with a USB Type-C® connector. ENERGY STAR available with a combination of high-performance CPU's, high-performance GPU's and select memory configurations.

The Z4 G4 is registered EPEAT® Silver in the US and Canada. EPEAT® registration varies by country. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options

The battery in this product complies with EU Directive 2006/66/EC

Battery mass: 3g

Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40ppm by weight

Restricted Material Usage This product meets the material restrictions specified in HP's General Specification for the Environment.

HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis

Low Halogen Statement

This product is low halogen except for power cords, external cables and peripherals. Service parts obtained after purchase may not be low halogen.

(Note: optional low halogen power cables are available for some countries in Europe)



Batteries

System Technical Specifications

and Recycling

HP Inc. Corporate Environmental Information **Additional Information**

End-of-Life Management HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life. For more information about HP's commitment to the environment:

Sustainability Report

Eco-label certifications ISO 14001 certificates

- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. Product Disassembly Instructions
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and IS01043.

Packaging

HP Workstation product packaging meets the HP's General Specification for the Environment

- Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment
- Does not contain ozone-depleting substances (ODS)
- Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed
- Maximizes the use of post-consumer recycled content materials in packaging materials
- All packaging material is recyclable
- All packaging material is designed for ease of disassembly
- Reduced size and weight of packages to improve transportation fuel efficiency
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting
- A multi-unit eco packaging option is available to institutional customers that uses less packaging material or has a lower volume footprint than conventional single-unit packaging. Please contact your sales representative for additional details.

Packaging Materials Internal External

Cushions and plastic bags made of low density polyethylene (LDPE). Outer carton, accessories carton, and insert made of corrugated paper board.

Manageability

Industry Standard Specifications

Intel® Xeon® W Processor Family

This product meets the following industry standard specifications for manageability functionality:

DASH 1.1 (via Intel® LAN on motherboard)

Technology (AMT)

Intel Active Management Intel® Active Management Technology (AMT) 11.1x

An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 11.1x includes the following advanced management functions:

- Power Management (on, off, reset, graceful shutdown, sleep and hibernate)
 - Support in Max Power Savings (Shutdown and Hibernate Modes)
- Hardware Inventory (includes BIOS and firmware revisions)

Intel® Core™ X-series Processors

None apply



System Technical Specifications

- **Hardware Alerting**
- Agent Presence
- **System Defense Filters**
- Serial Over LAN (SOL)
- USB Redirect (Media Redirection)
- ME Wake-on-LAN (WOL), even with **Maximum Power Savings Enabled**
- DASH 1.1 compliance
- **IPv6** Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections. or alert triggered connection
- Remote Scheduled Maintenance preschedule when the system connects to the IT or service provider console for maintenance.
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Local Time Sync to UTC
- Remote Memory Dump Command -Creates memory dump for debug

Intel® vPro™ Technology The HP Z4 G4 Workstation supports Intel® vPro™ technology when configured as outlined below:

- Intel® Xeon® processor W-2100 product family featuring Intel® vPro™ Technology
- Intel® C422 chipset
- Intel® I219LM GbE LAN

Remote Manageability Software Solutions

The HP Z4 G4 Workstation is supported on the following optional remote manageability software consoles:

- LANDesk Management Suite (HP recommended solution)
- Microsoft System Center Configuration Manager

For questions or support for manageability needs, please visit

http://www.hp.com/go/easydeploy

Not supported

Microsoft System Center Configuration Manager



System Technical Specifications

System Software Manager

For easydeploy questions or support for SSM, please visit: http://www.hp.com/go/ssm

Service, Support, and Warranty

On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. **NOTE 2:** On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Service levels and response times for HP Care Packs may vary depending on your geographic location.

Product Change Notification

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.



Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	N/A
Hard Drives	1TB SATA 7200 RPM
Graphics	N/A



Technical Specifications - Processors

Intel® Xeon® W-Series CPU

Intel® Xeon® W-2295 3.0 2933 18C CPU

Intel® Xeon® W-2275 3.3 2933 14C CPU

Intel® Xeon® W-2265 3.5 2933 12C CPU

Intel® Xeon® W-2255 3.7 2933 10C CPU

Intel® Xeon® W-2245 3.9 2933 8C CPU

Intel® Xeon® W-2235 3.8 2933 6C CPU

Intel® Xeon® W-2225 4.1 2933 4C CPU

Intel® Xeon® W-2223 3.6 2933 4C CPU

Intel® Xeon® W-2145 3.7 2666 8C CPU

Intel® Xeon® W-2133 3.6 2666 6C CPU

Intel® Xeon® W-2125 4.0 2666 4C CPU

Intel® Xeon® W-2123 3.6 2666 4C CPU

Intel® Xeon® W-2104 3.2 2400 4C CPU

Intel® Xeon® W-2102 2.9 2400 4C CPU

Intel® Core™ X-Series CPU

Intel® Core™ i9-10980XE 3.0 2933 18C CPU

Intel® Core™ i9-10940X 3.3 2933 14C CPU

Intel® Core™ i9-10920X 3.5 293312C CPU

Intel® Core™ i9-10900X 3.7 2933 10C CPU

Intel® Core™ i7-9800X 3.8 2666 8C CPU

Note: This list is just to indicate support, not availability. The above processors have all been qualified with the HP Z4 G4, but may not be available to order.



Technical Specifications - Hard Drives

STORAGE/HARD DRIVES

HP SAS (Serial Attached HP 300GB SAS 15K SFF SCSI) Hard Drives for HP HDD

Workstations

Capacity300GBHeight5.9 in; 15 cm

Width Media Diameter 3.5 in; 8.9 cm

Interface 12Gb/s SAS

Synchronous Transfer Up to 1200 MB/s (SAS single port)*

Rate (Maximum)

Buffer 128MB

Seek Time (typical reads, Average 2.0ms *

includes controller overhead, including settling)

Rotational Speed 15K rpm

Operating Temperature 41° to 131° F (5° to 55° C)

*Actual performance may vary.



Technical Specifications - Hard Drives

SATA (Serial ATA) Hard **Drives for HP Workstations**

500GB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 500GB Height 1 in: 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s*

Rate (Maximum)

Buffer **16MB**

Seek Time (typical reads. Single Track 2 ms* includes controller **Average** 11 ms* overhead, including Full Stroke 21 ms* settling)

Rotational Speed 7,200 rpm **Logical Blocks** 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

1TB Capacity

Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Up to 600 MB/s*

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Buffer 64MB Cache Adaptive

Seek Time (typical reads. **Single Track** 2 ms* includes controller Average 11 ms* overhead, including **Full Stroke** 21 ms* settling)

Rotational Speed 7,200 rpm

Operating Temperature 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD CMR

Capacity 2.0TB Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in: 8.9 cm

Up to 600 MB/s*

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer

Rate (Maximum)

64MB

Seek Time (typical reads, **Single Track** 1.0 ms* includes controller Average 11 ms* overhead, including **Full Stroke** 18 ms*

settling)

Buffer

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

Rotational Speed 7,200 rpm **Logical Blocks** 3,907,029,168

Operating Temperature 41° to 131° F (5° to 55° C)

*Actual performance may vary.

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD SMR

Capacity 2.0TB Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in: 10.17 cm

Serial ATA (6.0 Gb/s), NCQ Enabled Interface

Synchronous Transfer

Rate (Maximum)

Up to 600 MB/s*

64MB Buffer

Seek Time (typical reads, **Single Track** 1.2 ms* includes controller **Average** 12 ms* overhead, including **Full Stroke** 21 ms* settling)

Rotational Speed 7,200 rpm **Logical Blocks** 3,907,029,168

Operating Temperature 41° to 140° F (5° to 60° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)

1TB Capacity **Protocol** SATA **Form Factor** 3.5" **Controller** AHCI Reliability (MTBF) 2.0M hours **Rated Power On Hours** 8760/yr **Annualized Failure Rate** <0.62%

(based on Rated POH)

YES

Rated for 24/7/365

operation

Physical Size (Height) 1 in; 2.54 cm

Physical Size (Width) 4 in; 10.17 cm **Media Diameter** 3.5 in; 8.9 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Up to 600MB/s*

Buffer 128MB

Seek Time (typical reads, Single Track 0.32ms* includes controller Average 7.45ms* overhead, including **Full Stroke** 14.2ms*

settling)

Operating Temperature 41° to 140° F (5° to 60° C)

Performance **Sequential Read** up to 226MB/s*

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

Sequential Write

up to 226MB/s*

Enterprise Class Features High Reliability

*Actual performance may vary.



Technical Specifications - Hard Drives

4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) **Capacity** 4TB

Height 0.275 in; 0.7 cm

Width Media Diameter 2.5 in; 6.36 cm

Up to 600MB/s*

Physical Size 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Buffer 128MB

Seek Time (typical reads,
includes controller
overhead, including
attrice)Single Track
Average0.7ms*8.5ms*
Full Stroke15.7ms*

settling)

Rotational Speed 7,200 rpm

Operating Temperature 32° to 140° F (0° to 60° C)

*Actual performance may vary.

500GB SATA 7.2K SED SFF HDD Capacity 500GB

Height 0.275 in; 0.7 cm

Width Media Diameter 2.5 in; 6.36 cm

Physical Size 2.75 in; 6.99 cm

25ms (typical)*

Interface Serial ATA (6Gb/s)
Synchronous Transfer Up to 600MB/s*

Rate (Maximum)

Buffer 32MB

Full Stroke

settling)

Rotational Speed 7,200 rpm

Operating Temperature 32° to 140° F (0° to 60° C)

*Actual performance may vary.

Technical Specifications - Hard Drives

SATA SSDs for	HP		
Workstations			

HP 256GB SATA 6Gb/s SSD

Capacity 256GB **Protocol** SATA **Form Factor** 2.5" Controller AHCI **NAND Type** 3D TLC

192TBW (TB Written) **Endurance**

Reliability (MTTF) 1.5M hours Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in; 6.36 cm Interface SATA 6Gb/s **Synchronous Transfer** Up to 600MB/s*

Rate (Maximum)

Operating Temperature

32° to 158° F (0° to 70° C)

Performance

Sequential Read 530MB/s (max)* **Sequential Write** 500MB/s (max)* **Random Read** 55K IOPS (max)* 83K IOPS (max)* **Random Write**

HP 256GB SATA 6Gb/s SED Opal 2 SSD

256GB Capacity **Protocol** SATA **Form Factor** 2.5" **Controller AHCI NAND Type** 3D TLC

Endurance 192TBW (TB Written)

Reliability (MTTF) 1.5M hours Physical Size (Height) 0.28 in: 0.7 cm Physical Size (Width) 2.5 in; 6.36 cm Interface 6Gb/s SATA

Synchronous Transfer Rate (Maximum)

Up to 550MB/s (Sequential Read)*

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 530MB/s*

Sequential Write 500 MB/s* **Random Read** 55K IOPS* **Random Write** 83K IOPS*

Self-Encrypting Drive

OPAL 2

Support

*Actual performance may vary.

HP 512GB SATA 6Gb/s

SSD

Capacity 512GB **Protocol** SATA 2.5" **Form Factor** Controller AHCI **NAND Type** 3D TLC

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

388TBW (TB Written) **Endurance**

Reliability (MTTF) 1.5M hours Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in; 6.36 cm Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 550MB/s (Sequential Read)*

Operating Temperature

Performance

32° to 158° F (0° to 70° C)

Sequential Read 530 MB/s* **Sequential Write** 500 MB/s*

Random Read 95K IOPS* **Random Write** 83K IOPS*

HP 512GB SATA SED SSD

Capacity 512GB **Protocol** SATA **Form Factor** 2.5" **Controller** AHCI **NAND Type** 3D TLC

388TBW (TB Written) **Endurance**

Reliability (MTTF) 1.5M hours Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in: 6.36 cm Interface SATA 6Gb/s **Synchronous Transfer** Up to 600MB/s*

Rate (Maximum)

32° to 158° F (0° to 70° C)

Operating Temperature Performance **Sequential Read**

> **Sequential Write** 500 MB/s* **Random Read** 95K IOPS* **Random Write** 83K IOPS*

530 MB/s*

Self-Encrypting Drive

Support

OPAL 1 and 2

*Actual performance may vary.

HP 1TB SATA 6Gb/s SSD

Capacity 1TB Protocol SATA **Form Factor** 2.5" **Controller** AHCI **NAND Type** 3D TLC

Endurance 400TBW (TB Written)

Reliability (MTTF) 1.5M hours Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in; 6.36 cm Interface SATA 6Gb/s

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

Synchronous Transfer

Rate (Maximum)

Performance

Up to 550MB/s (Sequential Read)*

Operating Temperature

Sequential Read

Random Write

530 MB/s*

Sequential Write 500 MB/s*
Random Read 95K IOPS*

32° to 158° F (0° to 70° C)

83K IOPS*

HP 2TB SATA 6Gb/s SSD

Capacity2TBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLC

Endurance 400TBW (TB Written)

Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 550MB/s (Sequential Read)*

Operating Temperature 32° to 158° F (0° to 70° C)

Performance

Sequential Read 530 MB/s*
Sequential Write 500 MB/s *
Random Read 95K IOPS*
Random Write 83K IOPS*

*Actual performance may vary.

HP Enterprise Class 240GB SATA SSD

Capacity240GBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLC

Endurance 2,200TBW (TB Written)

Reliability (MTTF) 2.0M hours
Physical Size (Height) 0.28 in; 0.7 cm
Physical Size (Width) 2.5 in; 6.36 cm
Interface 6Gb/s SATA
Synchronous Transfer Up to 600MB/s*

Rate (Maximum)

Operating Temperature

32° to 158° F (0° to 70° C)

Performance

Sequential Read 540 MB/s*
Sequential Write 310 MB/s*
Random Read 93K IOPS*

Random Write 48K IOPS*

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

Enterprise Class Features High Endurance NAND

Power Loss Protection End-to-End Data Protection

*Actual performance may vary.

HP Enterprise Class 480GB SATA SSD Capacity480GBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLC

Endurance 4,400TBW (TB Written)

Reliability (MTTF)

Physical Size (Height)

Physical Size (Width)

2.5 in; 6.36 cm

Interface

Synchronous Transfer
Rate (Maximum)

2.0 M hours

0.28 in; 0.7 cm

2.5 in; 6.36 cm

Up to 600MB/s*

Operating Temperature

32° to 158° F (0° to 70° C)

Performance

Sequential Read 540 MB/s*
Sequential Write 460 MB/s*
Random Read 93K IOPS*
Random Write 74K IOPS*

Enterprise Class Features High Endurance NAND

Power Loss Protection End-to-End Data Protection

Performance PCIe	SSD
for HP Workstatio	ns

HP Z Turbo Drive 256GB M.2 2280 TLC SSD Capacity 256GB Protocol PCle **Form Factor** M.2 Controller NVMe **NAND Type** 3D TLC **SED Support** Opal 2 **Endurance** 200TB Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s *

Sequential Write 2200 MB/s *
Random Read 240K IOPS *
Random Write 480K IOPS *

HP ZTurbo Drive 512GB M.2 2280 TLC SSD Capacity 512GB Protocol PCIe

Note: Features and supported configurations will differ between the Z4 G4 Workstations with Intel® Xeon® W processors and with Intel® Core™ X-Series processors.

See the Supported Configuration section for supported configurations.

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

Form Factor M.2
Controller NVMe
NAND Type 3D TLC
SED Support Opal 2
Endurance 300TB
Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 2900 MB/s*
Random Read 460 K IOPS*
Random Write 500K IOPS*

HP ZTurbo Drive 1TB M.2 Capacity 2280 TLC SSD Protocol

Capacity 1TB
Protocol PCIe
Form Factor M.2
Controller NVMe
NAND Type 3D TLC
SED Support Opal 2
Endurance 400TB
Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 3000 MB/s*
Random Read 580K IOPS*
Random Write 500K IOPS*

HP ZTurbo Drive 2TB M.2 Capacity 2280 TLC SSD Protocol

Capacity 2TB
Protocol PCle
Form Factor M.2
Controller NVMe
NAND Type 3D TLC
SED Support Opal 2
Endurance 500TB
Reliability (MTTF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3300 MB/s*

Sequential Write 2400 MB/s*
Random Read 500K IOPS*



^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

Random Write 440K IOPS*

*Actual performance may vary.

HP Z Turbo Drive Quad Pro 2x256GB PCIe TLC SSD Capacity 512GB Protocol PCIe

Form Factor PCIe Card, Full Height PCIe Slot

Controller NVMe
NAND Type 3D TLC
SED Support Opal 2
Endurance 200TB
Reliability (MTBF) 1.5M hours

Interface PCIe Gen3 x4 architecture **Operating Temperature** 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 2200 MB/s*
Random Read 240K IOPS*
Random Write 480K IOPS*

HP Z Turbo Drive Quad Pro 2x512GB PCIe TLC SSD Capacity 1TB Protocol PCIe

Form Factor PCIe Card, Full Height PCIe Slot

ControllerNVMeNAND Type3D TLCSED SupportOpal 2Endurance300TBReliability (MTBF)1.5M hours

InterfacePCIe Gen3 x4 architectureOperating Temperature32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 2900 MB/s*
Random Read 460 K IOPS*
Random Write 500K IOPS*

HP Z Turbo Drive Quad Pro Capacity 2TB 2x1TB PCle TLC SSD Protocol PCle

Form Factor PCIe Card, Full Height PCIe Slot

Controller NVMe
NAND Type 3D TLC
SED Support Opal 2
Endurance 400TB

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)



^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

Performance	Sequential Read	3500 MB/s*
	Sequential Write	3000 MB/s*
	Random Read	580K IOPS*
	Random Write	500K IOPS*

^{*}Actual performance may vary.

HP Z Turbo Drive Dual Pro 256GB SSD **Capacity** 256GB **Protocol** PCle

Form Factor M.2 in Half-height, half-length card

Controller NVMe NAND Type 3D TLC

Endurance 200TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 2200 MB/s*
Random Read 240K IOPS*
Random Write 480K IOPS*

^{*}Actual performance may vary.

HP Z Turbo) Drive	Dual
Pro 512GB	SSD	

Capacity 512GB Protocol PCle

Form Factor M.2 in Half-height, half-length card

Controller NVMe
NAND Type 3D TLC

Endurance 300TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 2900 MB/s*
Random Read 460 K IOPS*
Random Write 500K IOPS*

HP Z Turbo Drive Dual Pro 1TB SSD Capacity 1TB Protocol PCIe

Form Factor M.2 in Half-height, half-length card

Controller NVMe NAND Type 3D TLC

Endurance 400TBW (TB Written)

Reliability (MTBF) 1.5M hours



^{*}Actual performance may vary.

Technical Specifications - Hard Drives

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

> **Sequential Write** 3000 MB/s* **Random Read** 580K IOPS* **Random Write 500K IOPS***

HP Z Turbo Drive Dual Pro 2TB SSD

Capacity 2TB **Protocol PCIe**

Form Factor M.2 in Half-height, half-length card

Controller NAND Type 3D TLC

Endurance 500TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

> **Sequential Write** 3000 MB/s * **Random Read** 600K IOPS* **Random Write 500K IOPS***

Mainstream PCIe SSDs for HP Workstations

HP 256GB M.2 2280 TLC

SSD

Capacity 256GB **Protocol PCIe Form Factor** M.2 **Controller** NVMe **NAND Type** 3D TLC 200TB **Endurance** Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance **Sequential Read** 3100 MB/s *

> **Sequential Write** 1400 MB/s * **Random Read** 200 K IOPS * **Random Write** 320 K IOPS *

HP 512GB M.2 2280 TLC

SSD

Capacity 512GB **Protocol PCIe Form Factor** M.2 Controller NVMe **NAND Type** 3D TLC **Endurance** 300TB Reliability (MTBF) 1.5M hours

^{*}Actual performance may vary.

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3300 MB/s*

Sequential Write 2500 MB/s*
Random Read 225 K IOPS*
Random Write 430 K IOPS*

HP 1TB M.2 2280 TLC SSD Capacity 1TB

Protocol PCIe
Form Factor M.2
Controller NVMe
NAND Type 3D TLC
Endurance 400TB
Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3300 MB/s*

Sequential Write 2500 MB/s*
Random Read 400 K IOPS*
Random Write 440 K IOPS*

HP 2TB M.2 2280 TLC SSD Capacity 2TB

Protocol PCIe
Form Factor M.2
Controller NVMe
NAND Type 3D TLC
Endurance 500TB
Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3300 MB/s*

Sequential Write 2700 MB/s*
Random Read 430 K IOPS*
Random Write 500 K IOPS*

Intel® 905p Series AIC PCIe SSD

Intel® 905p Series AIC 280GB PCIe SSD Capacity 280GB Protocol PCIe

Form Factor PCIe Card, Half Height

Controller NVMe NVM Type 3DXPoint



^{*}Actual performance may vary.

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

Endurance 5.11 PBW (PB Written)

Reliability (MTBF) 1.6M hours

Operating Temperature 32° to 185° F (0° to 85° C)

Performance Sequential Read 2730 MB/s*

Sequential Write 2280 MB/s*
Random Read 587K IOPS*
Random Write 559K IOPS*

*Actual performance may vary.

Intel® 905p Series AIC 480GB PCIe SSD

Capacity 480GB Protocol PCIe

Form Factor PCIe Card, Half Height

Controller NVMe NVM Type 3DXPoint

Endurance 8.76 PBW (PB Written)

Reliability (MTBF) 1.6M hours

Operating Temperature 32° to 185° F (0° to 85° C)

Performance Sequential Read 2710 MB/s*

Sequential Write 2280 MB/s*
Random Read 582K IOPS*
Random Write 561K IOPS*

^{*}Actual performance may vary.

Technical Specifications - Hard Drive Controllers

HARD DRIVE CONTROLLERS

MicroSemi 2100-4i4e 8port SAS 12Gb/s RAID Card **PCI Bus** 8 lanes, PCI Express 3.0

RAID Levels Offers Integrated RAID (0, 1, and 10) **PCI Data Burst Transfer** Half Duplex x8, PCIe, 8000 MB/s

Rate

SAS Bandwidth Half Duplex 1200 MB/s per lane

PCI Card Type 3.3V Add-in Card PCI Voltage 12 V ± 10%

PCI Power 9.8W typical, Airflow min 200 LFM

Bracket Full height and low profile **Certification Level** PCI Express 3.0 compliant

SAS ProcessorMicroSemi Series 8 SAS ControllerInternal ConnectorsOne x4 internal mini-SASHD (SFF-8643)External ConnectorsOne x4 external mini-SASHD (SFF-8644)

Maximum Number of SCSI 256 Non-RAID SAS/SATA devices

Devices

LED Indicators Connector for Drive Activity Light

NOTE: RAID 5 is not supported on MicroSemi 2100-4i4e 8-port SAS 12Gb/s

RAID Card



Technical Specifications - Graphics

GRAPHICS

NVIDIA® Quadro® P620 2GB Graphics Form Factor Dimensions: 2.713" H x 5.7" L

Single Slot, Low Profile Weight: 129 grams

Graphics Controller NVIDIA® Quadro® P620 Graphics Card

GPU: 512 CUDA cores Power: 40 Watts Cooling: Active

Bus Type PCI Express 3.0 x16

Memory Size: 2 GB GDDR5, 2000 MHz

Memory Interface: 128-bit Memory Bandwidth: 64 GB/s

Connectors 4mDP Outputs * **Maximum Resolution** DisplayPort™ 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output 4 mDP Connectors

Shading Architecture Full Microsoft DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.5

DirectX 12 Vulkan 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute, OpenCL

Available Graphics

Drivers

Windows 11 Windows 10 Windows 8.1 Windows 7 Linux

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes *P620 only have mini-DisplayPort™ (mDP) video ports.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters

included

After market option kit:Two mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or

Option Kit accessories:

- 2MY05AA - HP miniDP-to-DP Adapter Cables

2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® T400 Form Factor Dimensions: 2.713" H x 6.137" L



Technical Specifications - Graphics

2GB Graphics Single Slot, Low Profile

Weight: 124g

Graphics Controller NVIDIA® T400 Graphics Card

GPU: 384 CUDA cores Power: 30 Watts Cooling: Active

Bus Type PCI Express 3.0 x16
Memory Size: 2 GB GDDR6

Memory Interface: 64-bit Memory Bandwidth: 80 GB/s

Connectors 3x mDP

Maximum Resolution 3x 5120 x 2880 x 24 bpp @ 60Hz

Supported Graphics APIs OpenGL 4.5

DirectX 12 Vulkan 1.0

API support includes: CUDA, OpenCL 1.x

Available Graphics

Drivers

Windows 11 Windows 10 Linux

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® T600 4GB Graphics

Form Factor Dimensions: 2.713" H x 6.137" L

Single Slot, Low Profile Weight: 130 grams

Graphics Controller NVIDIA® T600 Graphics Card

GPU: 640 CUDA cores Power: 40 Watts Cooling: Active

Bus TypePCI Express 3.0 x16MemorySize: 4 GB GDDR6

Memory Interface: 128-bit Memory Bandwidth: 160 GB/s

Connectors 4x mDP

Maximum Resolution 4x 5120 x 2880 x 24 bpp @ 60Hz

Supported Graphics APIs OpenGL 4.5 DirectX 12

DirectX 12 Vulkan 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute, OpenCL

Available Graphics

Drivers

Windows 10

Linux



Technical Specifications - Graphics

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® Quadro® P1000 4GB Graphics Form Factor Dimensions:2.713" H x 5.7" L

Single Slot, Low Profile

Weight: 129 grams

Graphics Controller NVIDIA® Quadro® P1000 Graphics Card

GPU: 640 CUDA cores

Power: 47 WattsCooling: Active

Cooling: Active

Bus Type PCI Express 3.0 x16

Memory Size: 4 GB GDDR5, 2500 MHz

Memory Interface: 128-bit memory interface Memory Bandwidth: 80 GB/s memory bandwidth

Connectors 4mDP Outputs* **Maximum Resolution** DisplayPort 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz- supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output 4 mDP Connectors

Shading Architecture Full Microsoft DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.5

DirectX 12 Vulkan 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute, OpenCL

Available Graphics

Drivers

Windows 11 Windows 10 Windows 8.1 Windows 7 Linux

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes *P400, P600 and P1000 only have mini-DisplayPort™ (mDP) video ports.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters

included

After market option kit:Two mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or

Option Kit accessories:

- 2MY05AA - HP miniDP-to-DP Adapter Cables

2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Technical Specifications - Graphics

AMI	D Rac	leon™
RX (6700	XT

Form Factor Dual slot, Full Length (254mm L x 38mm W x 108.65mm H)

Graphics Controller AMD Radeon™ RX 6700 XT Graphics

GPU: 2560 Navi2 Stream Processors

Memory: 12GB GDDR6

Power: 230 Watts, Standard graphics 8pin + 6pin auxiliary power

Cooling: Active, Dual Axial fan

Bus Type PCI Express 4.0 x16

Connectors 3DP 1.4 + HDMI 2.1 Outputs

Maximum Resolution DisplayPort™ 1.4 with DSC:

- up to 4x 5210 x 3200 x 24 bpp @ 60Hz, uncompressed

- up to 7680 x 4320, compressed

Display Outputs 3 DP + 1 HMDI

Shading Architecture Microsoft DirectX 12 Shader Model 6.1

Supported Graphics APIs OpenGL 4.6

DirectX 12 Feature Level 12_1

Vulkan 1.1 OpenCL 2.2

Available Graphics

Drivers

Windows 11

Linux® 64-bit (selected distributions)

Typically, latest drivers will be available from amd.com

Notes This is a Prosumer or Consumer graphics card, and not a Professional

graphics card. As such, it does not have formal professional application validation, but is intended per AMD to function properly for game development, real-time engine, and many prosumer application workloads. Customers using Prosumer or Consumer graphic cards are likely to experience higher acoustics in comparison with Professional graphic cards. The higher acoustics observed with non-professional graphics is expected, as HP Workstations' designs do not have control in

this area.

Radeon™ Pro WX 3100 4GB Graphics

Form Factor Low-Profile Single Slot (6.6" Length)
Graphics Controller Radeon™ Pro WX 3100 Graphics Card

GPU: 512 Stream Processors organized into 8 Compute Units

Power: 50 Watts Cooling: Active 4GB GDDR5 memory

Memory 4GB GDDR5 memory

Memory Bandwidth: 6 Gbps / 96 GB/s

Memory Width: 128 bit

Connectors 2x Mini DisplayPort™ 1.4 plus 1x DisplayPort™ 1.4 – HDR ready connectors

with HBR3 and MST support.

Factory Configured: No adapters included

Technical Specifications - Graphics

After market option kit: One mDP-to-DP cable adapters included

Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or

Option Kit accessories.

Maximum Resolution

5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

3x 4K support @ 60Hz

Image Quality Features

Advanced support for 8-bit and 10-bit per RGB color component. High

bandwidth scaler for high quality up and downscaling

Display Output 3 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSync support

GPU Architecture

Supported Graphics APIs DirectX°12

Polaris

OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0

Available Graphics

Drivers

Windows 11

Windows 10

(Windows 7 64-bit available from AMD)

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

- 1. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
- 2. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 3. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDRready content chain, including: graphics card, monitor/TV. graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Radeon™ Pro WX 3200 **4GB Graphics**

Form Factor Graphics Controller Low-Profile Single Slot (2.75 "H x 6.6" L) Radeon™ Pro WX 3200 Graphics Card

GPU: 640 Stream Processors organized into 8 Compute Units

Power: 56 Watts Cooling: Active



Technical Specifications - Graphics

4GB GDDR5 memory Memory

> Memory Bandwidth: 96 GB/s Memory Width: 128 bit

Connectors 4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST

support.

Factory Configured: No adapters included

After market option kit: One mDP-to-DP cable adapters included

Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or

Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

4x 4K support @ 60Hz

Image Quality Features Advanced support for 8-bit and 10-bit per RGB color component. High

bandwidth scaler for high quality up and downscaling

Display Output 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSync support

GPU Architecture Polaris

Supported Graphics APIs DirectX°12

OpenGL® 4.6 OpenCL™ 2.0 Vulkan™ 1.0 Windows 11

Available Graphics

Drivers Windows 10

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

- 4. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
- 5. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 6. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDRready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded



Technical Specifications - Graphics

in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Radeon™ Pro WX 4100 4GB Graphics Form Factor Low-Profile Single Slot (6.6" Length)

Graphics Controller Radeon™ Pro WX 4100 Graphics card

GPU: 1024 Stream Processors organized into 16 Compute Units

Power: 50 Watts Cooling: Active

Memory 4GB GDDR5 memory

Memory Bandwidth: 6 Gbps / 96 GB/s

Memory Width: 128 bit

Connectors 4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST

support.

Factory Configured: Four mDP-to-DP cable adapters included After market option kit: Four mDP-to-DP cable adapters included

Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

4x 4K support @ 60Hz

Image Quality Features Advanced support for 8-bit and 10-bit per RGB color component. High

bandwidth scaler for high quality up and downscaling

Display Output 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSync support

GPU Architecture GCN 4th Generation

Supported Graphics APIs DirectX°12

OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0 Windows 11 Windows 10

Available Graphics

Drivers

Windows 10 Windows® 7 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

7. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

8. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which



Technical Specifications - Graphics

- are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 9. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDRready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windows mode content requires operating system support.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters

included

After market option kit: Four mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or **Option Kit accessories:**

10. 2MY05AA - HP miniDP-to-DP Adapter Cables

11. 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® T1000 4GB Graphics

Form Factor Dimensions: 2.713" H x 6.137" L

Single Slot

NVIDIA® T1000 Graphics Card **Graphics Controller**

Power: 50W Cooling: Active

PCI Express 3.0 x16 **Bus Type** Size: 4GB GDDR6 Memory

Memory Bandwidth: Up to 160 GB/s

Memory Width: 128-bit 4x mini DisplayPort™ 1.4a

Connectors Maximum Resolution 7680 x 4320 @ 120Hz **Display Output** Maximum number of displays: 4 displays

NVIDIA® Turing™ **Architecture**

Supported Graphics APIs

Available Graphics

Drivers

Windows 11 Windows 10

Windows 8.1

Microsoft Windows 7 Professional 64bit

Linux® - Full OpenGL® implementation, complete with NVIDIA® Quadro® and

ARB extensions

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® RTX A2000 6GB Graphics

Form Factor

Dimensions: 2.713" H x 6.6" L

Dual slot, half-height

Weight: 295 grams (without extender)

Graphics Controller NVIDIA® RTX A2000 Graphics Card

Power: 70W



Technical Specifications - Graphics

Cooling: Active

Bus Type PCI Express 4.0 x16 Memory Size: 6GB GDDR6

Memory Bandwidth: Up to 288 GB/s

Memory Width: 192-bit

Connectors 4x mini-DisplayPort™ 1.4a

Maximum Resolution Up to 4x 5120 x 2880 x 24bpp @ 60Hz

Architecture NVIDIA® Ampere™ Supported Graphics APIs CUDA, OpenCL™ 1.x **Available Graphics** Microsoft Windows 11 **Drivers** Microsoft Windows 10

Linux[®] 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes 1. RTX A2000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered

separately as AMO:

a. 2MY05AA - HP Single miniDP-to-DP Adapter Cable b. 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

2. Two mDP-to-DP adapters are included with the RTX A2000 when

it is ordered as an AMO kit.

NVIDIA® RTX A2000 12GB Form Factor

Notes

Graphics

Dimensions: 2.713" H x 6.6" L

Dual slot, half-height

Weight: 295 grams (without extender)

NVIDIA® RTX A2000 Graphics Card **Graphics Controller**

Power: 70W

Cooling: Active PCI Express 4.0 x16

Bus Type Size: 12GB GDDR6 Memory

Memory Bandwidth: Up to 288 GB/s

Memory Width: 192-bit

Connectors 4x mini-DisplayPort™ 1.4a

Maximum Resolution Up to 4x 5120 x 2880 x 24bpp @ 60Hz

NVIDIA® Ampere™ Architecture Supported Graphics APIs CUDA, OpenCL™ 1.x **Available Graphics** Microsoft Windows 11 **Drivers** Microsoft Windows 10

Linux[®] 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

http://welcome.hp.com/country/us/en/support.html

RTX A2000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered

separately as AMO:

a. 2MY05AA - HP Single miniDP-to-DP Adapter Cable

2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Technical Specifications - Graphics

Two mDP-to-DP adapters are included with the RTX A2000 when it is ordered as an AMO kit.

NVIDIA® Quadro® P4000 8GB Graphics Form Factor

Dimensions: 4.4"H x 9.5"L

Single-slot, full-height

Weight: 475 grams (without extender)

Graphics Controller NVID

NVIDIA® Quadro® P4000 Graphics Card

GPU: 1792 CUDA cores Power: 120 Watts Cooling: Active

Bus Type Memory PCI Express 3.0 x16 Size: 8GB GDDR5

Memory Bandwidth: 243 GB/s Memory Width: 256-bit

Connectors

4 x DisplayPort 1.4

3-pin mini-DIN connector via optional bracket

1 x 6-pin auxiliary power connector 4-pin header for stereo signal SYNC connector for Quadro® Sync II

2 x SLI connectors

Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included

Additional DisplayPort-to-VGA, DisplayPort-to-HDMI, or DisplayPort-to-DVI adapters are available as accessories

Maximum Resolution

Dual-link internal TMDS (DVI 1.0):

- up to 2560 x 1600 x 32 bpp @ 60 Hz

Single-link internal TMDS (DVI 1.0): - up to 1920 x 1200 x 32 bpp @ 60 Hz

HDMI[™] 2.0b (requires DP to HDMI adapter): - up to 5120 x 2880 x 24 bpp @ 60Hz

DisplayPort:

- up to 4096 x 2160 x 30 bpp @ 60Hz- up to 2560 x 1600 x 30 bpp @ 120 Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

Using two DP outputs, the P4000 can drive one dual DP input display with

5120 x 2880 x 30 bpp @ 60Hz resolution.

Image Quality Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB color

component.

HDCP 2.2 support over DisplayPort, DVI, and HDMI connectors

NVIDIA 3D Vision™ and other 3D stereo technologies

NVIDIA Mosaic and nView

Display Output

Maximum number of displays



Technical Specifications - Graphics

- 4 direct attached monitors

Maximum number of monitors across all available Quadro P4000 outputs

is 4.

Shading Architecture Supported Graphics APIs OpenGL 4.5

Shader Model 5.1

DirectX 12 Vulcan 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers

Windows 11 Windows 10 Windows 7

Linux® - Full OpenGL implementation, complete with NVIDIA and ARB

extensions

HP qualified drivers may be preloaded or available from the HP support

http://welcome.hp.com/country/us/en/support.html

Notes

2. Quadro P4000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be

ordered separately.

Quadro P4000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

NVIDIA® Quadro® P5000 16GB Graphics

Form Factor

Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 815 grams / 1.80 lbs

Graphics Controller

NVIDIA® Quadro® P5000 graphics

GPU: 2560 NVIDIA® CUDA® Parallel Processing Cores

Power: 180 Watts Cooling: Active

Memory 16GB GDDR5X memory

Memory Bandwidth: Up to 288 GB/s

Memory Width: 256 bit

ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

DL-DVI(D)

3-pin mini-DIN connector

SLI connector

NVIDIA® Quadro® Sync connector (compatible with NVIDIA® Quadro®

II Sync)

One 8-pin auxiliary power connector

Technical Specifications - Graphics

Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to

Dual-Link DVI adapters available as accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB color

component.

HDCP 2.2 support over DisplayPort™, DVI, and HDMI

connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies NVIDIA Mosaic and nView Desktop Management

Display Outputs¹ 4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K

at 30Hz)

1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @

120 Hz)

GPU Architecture NVIDIA Pascal™

Supported Graphics APIs DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0,

OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows 11 Windows 10

Windows 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

NVIDIA® Quadro® P6000 24GB Graphics **Form Factor** Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 967 grams / 2.14 lbs

Graphics Controller NVIDIA® Quadro® P6000 graphics

GPU: 3840 NVIDIA® CUDA® Parallel Processing Cores

Power: 250 Watts Cooling: Active



Technical Specifications - Graphics

Memory 24GB GDDR5X memory

Memory Bandwidth: Up to 432 GB/s

Memory Width: 384 bit

ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

DL-DVI(D)

3-pin mini-DIN connector

SLI connector

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort[™] to VGA, DisplayPort[™] to DVI, and DisplayPort[™]

to Dual-Link DVI adapters available as accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB color

component.

HDCP 2.2 support over DisplayPort, DVI, and HDMI connectors

NVIDIA 3D Vision™ and other 3D stereo technologies

NVIDIA Mosaic and nView

Display Outputs¹ 4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K

at 30Hz)

1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @

120 Hz)

GPU Architecture NVIDIA Pascal™

Supported Graphics APIs DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0,

OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows 11 Windows 10 64-bit

Windows 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

Technical Specifications - Graphics

NVIDIA® Quadro® GP100 16GB Graphics **Form Factor** Dual Slot (4.4" Height x 10.5" Length)

Weight: 989 grams +72 grams extender

Graphics Controller NVIDIA® QUADRO® GP100

GPU: 3584 NVIDIA CUDA® Parallel Processing Cores

Power: 235 Watts Cooling: Active

Memory 16GB HBM2

Memory Bandwidth: Up to 717 GB/s

Memory Width: 4096-bit

ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

DL-DVI(D)

3-pin mini-DIN connector via optional bracket

4-pin header for stereo signal

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

(2x) NVLink connectors

Factory configured option: 8-pin power adapter included with card. After market option Kit: 8-pin power adapter included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and

DisplayPort™ to Dual-Link DVI adapters available as accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features HDR support over DisplayPort™ 1.4 (SMPTE 2084/2086,

BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60

Hz 10b HEVC Encode)

HDCP 2.2 support over DisplayPort™, DVI, and HDMI

connectors

NVIDIA 3D Vision™ technology

NVIDIA Mosaic and nView Desktop Management

Display Outputs 4x DP1.4 MST & HDR2 outputs (up to 5120 x 2880 @ 60Hz)

1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz)
1x Single-link DVI-D output (up to 1920 x 1200 @ 60 Hz)

HDMI[™] 2.0b (up to 5120 x 2880 @ 60Hz)*

*requires DP to HDMI adapter



Technical Specifications - Graphics

GPU Architecture NVIDIA Pascal™

Supported Graphics

APIs

DirectX®12, OpenGL® 4.5, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL, Java, Python, and Fortran

Available Graphics

Drivers

Windows 11 Windows 10

Windows 7 Professional 64-bit

Linux®

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters

included

After market option kit: No adapters included

NVIDIA® Quadro® GV100 32GB Graphics **Form Factor**

Dual Slot (4.4" Height x 10.5" Length) Weight: 980 grams + 72 grams extender

Graphics Controller

NVIDIA® OUADRO® GV100

GPU: 5120 NVIDIA® CUDA® Parallel Processing Cores

Power: 250 Watts Cooling: Active

Memory 32GB HBM2 memory

Memory Bandwidth: Up to 870 GB/s

Memory Width: 5120-bit

ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

3-pin mini-DIN connector via optional bracket

4-pin header for stereo signal

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

(2x) NVLink for GV100 connectors (via optional kit)

After market option Kit: no power adapter included with card.

DisplayPort[™] to VGA, DisplayPort[™] to DVI (single-link and dual-link), and

DisplayPort™ to HDMI adapters available as accessories.



Technical Specifications - Graphics

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features HDR support over DisplayPort™ 1.4 (SMPTE 2084/2086, BT.

2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b

HEVC Encode)

HDCP 2.2 support over DisplayPort™ and HDMI connectors

NVIDIA 3D Vision™ technology

NVIDIA Mosaic and nView Desktop Management

Display Outputs 4x DP1.4 HDR2 outputs (up to 5120 x 2880 @ 60Hz)

GPU Architecture NVIDIA® Volta™

Supported Graphics APIs DirectX®12, OpenGL® 4.5

Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0,

OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows 11

Windows 8 & 8.1 64-bit Windows 7 64-bit

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Factory Configured (Z4/Z8 G4 Workstation): No adapters included

After market option kit: No adapters included

NVIDIA® Quadro® RTX 4000 8GB Graphics

Form Factor

Full-Height Single Slot (4.4" Height x 9.5" Length)

Weight: 550 grams / 1.21 lbs

Graphics Controller

NVIDIA® Quadro® RTX 4000 Graphics

IGPU: 2304 NVIDIA® CUDA® Parallel Processing Cores

Power: 160 Watts Cooling: Active

Memory

8GB GDDR6 memory

Memory Bandwidth: Up to 416 GB/s

Memory Width: 384 bit

Technical Specifications - Graphics

Connectors 3x DP 1.4a and VirtualLink

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to

Dual-Link DVI adapters available as accessories.

Maximum Resolution 7680x4320 @ 60Hz

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB color

component.

HDCP 2.2 support over DisplayPort™, DVI, and HDMI

connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs¹ 3x DP 1.4a and VirtualLink² (7680x4320 @ 60Hz)

Supported Graphics APIs DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0,

OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows 11 Windows 10 Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

2- VirtualLink's USB-C™ (data) cannot be disabled at a hardware

level

NVIDIA® RTX A4000 16GB Graphics Form Factor

Full-Height Single Slot (4.4" Height x 9.5" Length)

Graphics Controller NVIDIA® RTX A4000 Graphics

GPU: 6144 NVIDIA® CUDA® Parallel Processing Cores

Power: 140 Watts Cooling: Active

Memory 16GB GDDR6 memory

Memory Bandwidth: Up to 448 GB/s

Memory Width: 256 bit

Connectors 4x DP

One 6-pin auxiliary power connector



Technical Specifications - Graphics

Factory configured option: No video cable adapter included with

card.

After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and

DisplayPort™ to Dual-Link DVI adapters available as accessories.

Maximum Resolution 7680x4320 @ 60Hz

Display Outputs¹ 4x DP

Supported Graphics

APIs

DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows 11 Windows 10

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® RTX A4500 20GB Graphics **Form Factor**

Full-Height Dual Slot (4.4" Height x 10.5" Length)

Graphics Controller

NVIDIA® RTX A4500 Graphics

GPU: 7168 NVIDIA® CUDA® Parallel Processing Cores

Power: 200 Watts Cooling: Active

Memory

20GB GDDR6 memory

Memory Bandwidth: Up to 640 GB/s

Memory Width: 320 bit

Connectors

4x DP

One 8-pin auxiliary power connector

Factory configured option: No video cable adapter included with

card.

After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and

DisplayPort™ to Dual-Link DVI adapters available as accessories.

Technical Specifications - Graphics

Maximum Resolution 7680x4320 @ 60Hz

Display Outputs¹ 4x DP

Supported Graphics

APIs

DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows 11 Windows 10

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® Quadro® RTX 5000 16GB Graphics

Form Factor Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 975 grams + 75 grams extender

Graphics Controller NVIDIA® QUADRO® RTX 5000

GPU: 3072 CUDA cores Power: 265 Watts Cooling: Active

Memory 16GB HBM2 memory

Memory Bandwidth: Up to 448 GB/s ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

3-pin mini-DIN connector via optional bracket

4-pin header for stereo signal

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

(2x) NVLink for RTX 5000 connectors (via optional kit)

After market option Kit: no power adapter included with card.

DisplayPort[™] to VGA, DisplayPort[™] to DVI (single-link and dual-link), and DisplayPort[™] to HDMI adapters available as accessories.

Maximum Resolution DisplayPort™ 1.4:

7680x4320 @ 60Hz

Image Quality Features HDR support over DisplayPort™ 1.4 (SMPTE 2084/2086,

BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60

Hz 10b HEVC Encode)



Technical Specifications - Graphics

HDCP 2.2 support over DisplayPort™ and HDMI

connectors

NVIDIA 3D Vision™ technology

NVIDIA Mosaic and nView Desktop Management

Display Outputs 4x DP1.4 HDR2 outputs (up to 7680x4320 @ 60Hz)

GPU Architecture NVIDIA® Volta™

Supported Graphics

APIs

DirectX®12, OpenGL® 4.5

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows 11 Windows 10

Windows 8 & 8.1 64-bit Windows 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Factory Configured (Z4/Z6/Z8 G4 Workstation): No adapters

included

After market option kit: No adapters included

*VirtualLink's USB-C™ (data) cannot be disabled at a hardware level

NVIDIA® Quadro® RTX 6000 24GB Graphics

Form Factor

Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 995 grams + 75 grams extender

Graphics Controller

NVIDIA® QUADRO® RTX 6000 GPU: 4608 CUDA cores

Power: 295 Watts Cooling: Active

Memory 24GB HBM2 memory

Memory Bandwidth: Up to 672 GB/s ECC Memory (disabled by default)

Technical Specifications - Graphics

Connectors DP (x4) with HDR support

3-pin mini-DIN connector via optional bracket

4-pin header for stereo signal

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

(2x) NVLink for RTX 5000 connectors (via optional kit)

After market option Kit: no power adapter included with card.

DisplayPort[™] to VGA, DisplayPort[™] to DVI (single-link and dual-link), and DisplayPort[™] to HDMI adapters available as accessories.

Maximum Resolution DisplayPort™ 1.4:

7680x4320 @ 60Hz

Image Quality Features HDR support over DisplayPort™ 1.4 (SMPTE 2084/2086,

BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60

Hz 10b HEVC Encode)

HDCP 2.2 support over DisplayPort™ and HDMI

connectors

NVIDIA 3D Vision™ technology

NVIDIA Mosaic and nView Desktop Management

Display Outputs 4x DP1.4 HDR2 outputs (up to 7680x4320 @ 60Hz)

GPU Architecture NVIDIA® Volta™

Supported Graphics

APIs

DirectX®12, OpenGL® 4.5

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows 11 Windows 10

Windows 10 Windows 8 & 8.1 64-bit

Windows 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Factory Configured (Z4/Z6/Z8 G4 Workstation): No adapters

included

After market option kit: No adapters included

*VirtualLink's USB-C™ (data) cannot be disabled at a hardware level

Technical Specifications - Graphics

NVIDIA® RTX A5000 24GB Graphics **Form Factor** Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 1049 grams + 80 grams extender

Graphics Controller NVIDIA® RTX A5000

GPU: 8192 CUDA Cores

Power: 230W Cooling: Active

Memory 24GB GDDR6

Memory Bandwidth: Up to 768GB/s ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

One 8-pin auxiliary power connector

After market option Kit: no power adapter included with card.

DisplayPort[™] to VGA, DisplayPort[™] to DVI (single-link and dual-link), and DisplayPort[™] to HDMI adapters available as accessories.

Maximum Resolution DisplayPort™ 1.4a:

7680x4320 @ 120Hz

Display Outputs 4x DP1.4a HDR2 outputs (up to 7680x4320 @ 120Hz)

GPU Architecture NVIDIA® Ampere™

Supported Graphics

APIs

DirectX®12, OpenGL® 4.5

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows 11 Windows 10 Windows 7 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Factory Configured (Z4/Z6/Z8 G4 Workstation): No adapters

included

After market option kit: No adapters included

NVIDIA® RTX™ A6000 48GB Graphics **Form Factor**

Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1230 grams / 2.71 lbs (with extender)

Technical Specifications - Graphics

Graphics Controller NVIDIA® RTX™ A6000 Graphics

GPU: 10752 NVIDIA® CUDA® Parallel Processing Cores

Power: 300 Watts Cooling: Active

Memory 48GB GDDR6 memory

ECC optional

Memory Bandwidth: Up to 768 GB/s

Memory Width: 384 bit

Connectors 4x DP 1.4a

Quadro Sync II connector

Ampere NVLink® Stereo Sync

Requires 8-pin CPU auxiliary power

Maximum Resolution 5120x2880 @ 60Hz (up to 4 displays)

Display Outputs 4x DP 1.4 (7680x4320 @ 60Hz)

Supported Graphics APIs DirectX°12, OpenGL° 4.6, OpenCL™ 1.0, Vulkan™ 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0,

OpenCL™, Java, Python, and Fortran™

Available Graphics

Drivers

Windows 11 Windows 10

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® Quadro® RTX 8000 48GB Graphics **Form Factor** Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 1070 grams / 2.35 lbs

Graphics Controller NVIDIA® Quadro® RTX 8000 Graphics

GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores

Power: 295 Watts Cooling: Active

Memory 48GB GDDR6 memory

Memory Bandwidth: Up to 672 GB/s

Memory Width: 384 bit



Technical Specifications - Graphics

Connectors 4x DP 1.4a and VirtualLink

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin + 6-pin auxiliary power connector

Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to

Dual-Link DVI adapters available as accessories.

Maximum Resolution 7680x4320 @ 60Hz

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB color

component.

HDCP 2.2 support over DisplayPort™, DVI, and HDMI

connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs¹ 4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)

Supported Graphics APIs DirectX[®]12, OpenGL[®] 4.5, OpenCL[™] 1.0, Vulkan[™] 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0,

OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

2- VirtualLink's USB-C™ (data) cannot be disabled at a hardware

level

AMD Radeon™ Pro W6800 Form Factor

32GB Graphics

Graphics Controller

Dual slot, Full-height (4.4" H x 10.5" L)

Radeon™ Pro W6800 graphics

GPU: 3840 cores Power: 261 Watts

Cooling: Active fan heatsink

Memory 32GB GDDR6 memory

Memory Bandwidth: Up to 512 GB/s

Memory Width: 256 bit

Connectors 6 mDP (miniDisplayPort™) 1.4 Connectors with DSC

Maximum Resolution Up to 6x 5120 x 2880 x 24 bpp @ 60Hz

Supports Multi-Stream Transport (MST)

Technical Specifications - Graphics

GPU Architecture RDNA™ 2 **Supported Graphics APIs** OpenGL® 4.6

DirectX® 12 Ultimate (HW RayTracing)

Vulkan™ 1.2

API support includes OpenCL™ 2.1

Available Graphics

Drivers

Windows 11 Windows 10 Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes W6800 only has mini-DisplayPort™ (mDP) video ports

Configure-to-order must specify AV options to add any required

mDP-to-DP Adapters

Two mDP-to-DP Adapters are included in the RTX A2000 AMO kits. If more mDP-to-DP Adapters are needed, Adapters can be ordered separately as

AMO:

2MY05AA - HP Single miniDP-to-DP Adapter Cable

2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Radeon™ Pro WX 7100 8GB Graphics Form Factor

Graphics Controller

Full-Height Single Slot (9.5" Length) Radeon™ Pro WX 7100 graphics

GPU: 2304 Stream Processors organized into 36 Compute Units

Power: 130 Watts Cooling: Active

Memory 8GB GDDR5 memory

Memory Bandwidth: 7 Gbps / 224 GB/s

Memory Width: 256 bit

Connectors 4x Display Port 1.4 – HDR ready connectors with HBR3 and MST support.

Factory Configured: No video cable adapter included After market option kit: No video cable adapter included

Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color

component. High bandwidth scaler for high quality up and

downscaling

Display Output 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs

Technical Specifications - Graphics

FreeSync support

GPU Architecture GCN 4th Generation

Supported Graphics APIs DirectX[®]12

OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0

Available Graphics

Drivers

Windows 11 Windows 10 Windows 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

- 12. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
- 13. Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro™ GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice.
- 14. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 15. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Radeon™ Pro WX 9100 16GB Graphics **Form Factor**

Dual Slot (4.4" Height x 10.5" Length)

Graphics Controller

Radeon™ Pro WX 9100 graphics GPU: 4096 Stream Processors

Power: 250 Watts Cooling: Active



Technical Specifications - Graphics

Memory 16GB HBM2 memory

Memory Bandwidth: Up to 483 GB/s

Memory Width: 2048 bit

Connectors 6x Mini DisplayPort 1.4 – HDR ready connectors with HBR3 and MST

support.

Factory Configured: No video cable adapter included After market option kit: No video cable adapter included

Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available as Factory Configuration or Option Kit accessories.

Maximum Resolution 8K support @ 60Hz

Single monitor, single or dual-cable

Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component.

High bandwidth scaler for high quality up and downscaling

Display Output 6 full physical mDP 1.4 HDR Ready outputs

FreeSync support

GPU Architecture Vega™

Supported Graphics APIs DirectX® 12.1

OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0

Available Graphics

Drivers

Windows 11 Windows 10

Windows 7 available from AMD

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

 HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

 Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro™ GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements

Technical Specifications - Graphics

recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice.

- 3. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 4. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included

After market option kit:Two mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories:

- 2MY05AA HP miniDP-to-DP Adapter Cables
- 2KW87A6 HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® Quadro® Sync II Part number 1WT20AA

Dimensions (HxD) 6.0 inches × 4.2 inches

Devices Supported NVIDIA® Quadro® P4000
NVIDIA® Quadro® P5000
NVIDIA® Ouadro® P6000

NVIDIA® Quadro® P5000 NVIDIA® RTX™ A6000 NVIDIA® RTX™ A5000 NVIDIA® RTX™ A4000

Bus Type Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power

connector

PCI Form Factor Full Height, half length, single slot

Ports 2 RJ45 connectors for carrying frame lock signals over CAT5 cables.

BNC Connector for external house synchronization.

Internal Connectors 6 NVIDIA SLI® style edge fingers for connection to compatible GPUs

 Included with the board are 4 12-Inch Short Sync Cables to connect to GPU's

 Included with the board are 2 24-Inch Long Sync Cables to connect to GPU's

to GPU S

System Requirements Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power

connector

Must be used with NVIDIA Quadro P4000, P5000 or P6000 graphics cards.

Requires Quadro driver version R375 or later.



Technical Specifications - Graphics

Temperature - 0° to 55° C

Operating

Temperature - Storage -40° to 60° C Relative Humidity - 10% to 80%

Operating

Power Requirements Board power dissipation: <15W

Operating Systems
Supported

Windows 10 Windows 7 64-bit Linux® 64-bit

Windows 11

Kit Contents Contains:

• Quadro Sync II Card

4 x 12-Inch Short Sync Cables2 x 24-Inch Long Sync Cables (Two)

Quick Start Guide



Technical Specifications – Optical and Removable Storage

OPTICAL AND REMOVABLE STORAGE

HP 9.5mm Slim DVD Writer

Description 9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Supported Media Types DVD+R

DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

> Full Stroke DVD < 200 ms (seek) Full Stroke CD < 200 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 8X

DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

Power Source SATA DC power receptacle

> 5 VDC ± 5%-100 mV ripple p-p **DC Power Requirements**

DC Current 5 VDC -< 800 mA typical, <1600 mA

maximum

84° F (29° C)

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions non-

condensing)

Relative Humidity Maximum Wet Bulb Temperature 10% to 80%

Kit Contents HP SATA DVD Writer drive, installation guide.

HP 9.5mm Slim DVD-ROM Description Drive

9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

SATA / ATAPI **Interface Type** Dimensions (WxHxD) 128 x 9.5 x 127mm

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB



Technical Specifications – Optical and Removable Storage

Access Times DVD-ROM Single Layer < 110 ms (typical)

CD-ROM Mode 1 < 110 ms (typical)
Full Stroke DVD < 230 ms (typical)
Full Stroke CD < 220 ms (typical)

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC - <800mA typical, < 1600 mA

maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing)

Relative Humidity 10% to 80% Maximum Wet Bulb Temperature 84° F (29° C)

Kit Contents 9.5mm Slim DVD-ROM Drive, 5.25" ODD Bay adapter/carrier, slim SATA

data/power cable, installation guide

HP HH DVD Writer (16X RW DVD-R)

Description HP Half Height DVD Writer **Mounting Orientation** Either Horizontal or vertical

Interface Type SATA

Dimensions (WxHxD) 146x42x165mm

Supported Media Types DVD+R

DVD+RW
DVD+R DL
DVD-R DL
DVD-R
DVD-RW
CD-R
CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Full Stroke DVD 145ms (seek)
Full Stroke CD 120ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 13X

DVD-RW Up to 13X DVD+R DL Up to 12X DVD-R DL Up to 12X DVD-ROM Up to 12X DVD-ROM DL Up to 12X DVD+R Up to 16X DVD-R Up to 16X

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC ± 5% -100 mV ripple p-p

12 VDC ± 10% -200 mV ripple p-p

DC Current 5 VDC -<1500mA typical, <2000 mA

maximum.

Temperature 41° to 122° F (5° to 50° C)



Technical Specifications – Optical and Removable Storage

Operating Environmental Relative Humidity

10% to 90% (Non-Condensing)

(all conditions noncondensing)

Operating Systems Supported

Windows 11, Windows 10, Windows 7 Professional 64-bit. Red Hat

Enterprise Linux WS4**,5,6 Desktop/Workstation.

No driver is required for this device, Native support is provided by

operating system.

Kit Contents HP SATA DVD Writer drive, Installation guide.

HP 9.5mm Slim BDXL Blu- Description **Ray Writer**

9.5mm height, tray-load

Mounting Orientation

Either horizontal or vertical

Interface Type

SATA/ATAPI

BD-ROM

Dimensions (WxHxD)

128 x 9.5 x 127mm

Supported Media Types

BD-R **BD-RE** DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity

DVD-ROM Blu-ray

8.5 GB DL or 4.7 GB standard

25 GB (single-layer) 50 GB (dual-laver)

100/128 GB (BDXL)

Full Stroke DVD < 230 ms (seek) Full Stroke CD < 220 ms (seek)

< 230 ms (seek) (Full Stroke Blu-ray) Blu-ray Startup Time (Time to drive ready from tray

loading)

BD-ROM (SL/DL) **25S / 28S** BD-R (SL/DL) 255 / 285 BD-RE (SL/DL) 255 / 285 DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 255 / 255

DVD-RW 25S

DVD+R (SL/DL) 255 / 255 DVD+RW **25S**

CD-ROM **15S**

Maximum Data Transfer CD ROM Read

Rates

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read

DVD+RW Up to 8X DVD-RW Up to 8X



Technical Specifications – Optical and Removable Storage

DVD+R DL Up to 8X
DVD-R DL Up to 8X
DVD-ROM Up to 8X
DVD-ROM DL Up to 8X
DVD+R Up to 8X
DVD-R Up to 8X
BD-ROM Up to 6X

Blu-ray BD-ROM Up to 6X

BD-ROM DL Up to 6X
BD-R Up to 6X
BD-R DL Up to 6X
BD-R Up to 6X
BD-RE SL/DL Up to 6X

41° to 122° F (5° to 50° C)

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC ± 5%-100 mV ripple p-p DC Current 5 VDC -900 mA typical, 2000mA

maximum

Operating Environmental Temperature (all conditions non-

condensing)

Relative Humidity 10% to 80% Maximum Wet Bulb Temperature 84° F (29° C)

Kit Contents 9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim

SATA data/power cable, installation guide

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

HP SD Card Reader

Description Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

Supports SD 4-bit parallel transfer mode

Interface Type

USB 3.1 G1 High-speed interface

Dimensions (WxHxD)

1.15 x .9 x .15 in (29.00 x 23.6 x 3.15 mm) Fits conveniently in the Front IO

Bay

Supported Media Types

Secure Digital Card (SD)

Secure Digital High Capacity (SDHC)
SD Extended Capacity Memory Card (SDXC)

SD Ultra High Speed II(SD UHSII)

These additional media types are supported with a card adapter.

miniSD

miniSD High Capacity

Micro SD Memory Card (MicroSD)

Micro SD High Capacity Memory Card (MicroSDHC)

Test Parameters/Conditions - Power applied, unit operating on system

±5%

Kit Contents SD card reader



Technical Specifications – Optical and Removable Storage

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0,

Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE,

BSMI, C-Tick, VCCI, MIC, cUL, TUVT

Weight 0.35 lbs. (0.16 kg)



Technical Specifications - Controller Cards

CONTROLLER CARDS

HP Thunderbolt-3 Dual Port2 PCIe 1-port I/O Card

Data Transfer Rate Supports up to 40 Gb/s (40,000 Mb/s) **Devices Supported**

Thunderbolt™. Thunderbolt™ 2 and Thunderbolt™ 3 certified for Windows

devices

Bus Type PCIe Slot. Slot 4 only

Ports Two Thunderbolt™ 3 external USB type-C output connectors (Rear)

Two full size DisplayPort input connectors (Rear)

Internal Connectors One 2x5-Pin header connector

Genuine Windows 10 Professional, slot 4 PCH PCIe slot. **System Requirements**

Temperature - Operating 50° to 131° F (10° to 55° C) Temperature - Storage -22° to 140° F (-30° to 60° C)

Relative Humidity -

Operating

20% to 80%

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD,

Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Genuine Windows 10 Professional.

Kit Contents HP Thunderbolt™ 3 Dual Port PCIe I/O Card, 2- DisplayPort cables, GPIO

(General-Purpose Input/Output) cables, Installation documentation and

warranty card.



^{*}Maximum speed requires DisplayPort™ and PCIe aggregation.

Technical Specifications - Networking and Communications

NETWORKING AND COMMUNICATIONS

Integrated Intel I219 PCIe Connector **GbE Controller**

Controller

Intel I219 GbE platform LAN connect networking controller

Data Rates Supported Boot ROM Support

10/100/1000 Mbps

Connect Speed LED Indicators

Link/Activity LED

Off = No link

Blinking = Activity

Speed LED

PXE, UEFI

RJ-45

Off = 10Mbps

Amber = 100Mbps

Green = 1000Mbps

Management Capabilities Wake-On-LAN, Intel® Active Management Technology™ (AMT) 11.1x

NOTE: Intel [®] AMT[™] is not available on Intel Core X configs.

Integrated Intel I210 (not available on Intel Core X configs)

Connector **RJ-45 Controller**

Intel® I210 **Data Rates Supported** 10/100/1000 Mbps

PXE. UEFI **Boot ROM Support** Link/Activity LED

Connect Speed LED Indicators

Off = No link

Blinking = Activity

Speed LED

Off = 10Mbps

Amber = 100Mbps

Green = 1000Mbps

Management Capabilities Wake-On-LAN

Intel® I210-T1

Networking Interface RJ-45

System Interface PCI Express 2.1 x1

Networking Speeds Supported

10Mbps, 100Mbps, 1Gbps

Cabling (up to 100m) Cat3 (or higher) for 10Mbps

> Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps

Power Consumption (active-typical)

0.81W

Physical Dimensions

Length: 6.7cm (2.64 inches)

(Bracket) Width: 1.8cm (0.709 inches)

Full-height end bracket: 12.07cm (4.755 inches) Low-profile end bracket: 8cm (3.15 inches)



Technical Specifications - Networking and Communications

Connect Speed LED Indicators

Link/Activity LED

Off = No link

Blinking = Activity

Speed LED

Off = 10Mbps

Green = 100Mbps

Amber = 1Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications

USA: FCC B. EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Intel® 1350-T2

Networking Interface

2 x RJ-45

System Interface

PCI Express 2.1 x4

Networking Speeds Supported

Cabling (up to 100m)

10Mbps, 100Mbps, 1Gbps

Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps

Cat5e (or higher) for 1Gbps

Power Consumption (active-typical)

4.4W

Physical Dimensions

Length: 13.54cm (5.33 inches) Width: 6.89 (2.71 inches)

Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches)

Connect Speed LED Indicators

Link/Activity LED

Off = No link

Blinking = Activity

Speed LED

Off = 10Mbps

Green = 100Mbps

Amber = 1Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications

USA: FCC B, EU: UL CE, Japan: VCCI,

Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Intel® 1350-T4

Networking Interface

4 x RJ-45

Technical Specifications - Networking and Communications

System Interface

Networking Speeds

Supported

PCI Express 2.1 x4

10Mbps, 100Mbps, 1Gbps

Cabling (up to 100m)

Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps

Power Consumption (active-typical)

Physical Dimensions

Length: 13.54cm (5.33 inches)

Width: 6.89 (2.71 inches)

Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches)

Connect Speed LED Indicators

Link/Activity LED

• Off = No link

• Blinking = Activity

Speed LED

Off = 10MbpsGreen = 100MbpsAmber = 1Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications

USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

2 x RJ-45

Canada: ICES-003/NMB-003

Intel® X550-T2

Networking Interface

System Interface PCI Express 3 x4

Networking Speeds

Supported

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100Mbps, 1Gbps, 2.5Gbps, 5Gbps, 10Gbps

Cabling (up to 100m) Cat5 (or higher) for 100Mbps

Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps

Cat6a (or higher) for 10Gbps

Power Consumption (active-typical)

3.9W at 100Mbps 5.5W at 1Gbps 11.2W at 10Gbps

Physical Dimensions

5.2 in x 2.7 in (without bracket)

Connect Speed LED Indicators

Link/Activity LED

Off = No link

Blinking = Activity

Speed LED

Off = No link

Amber = <10Gbps</p>

Green = 10Gbps

Technical Specifications - Networking and Communications

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications

USA: FCC B. EU: UL CE. Japan: VCCI. Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC.

Canada: ICES-003/NMB-003

Allied Telesis AT-2914SX/LC-901 1GB LC Fiber NIC

Network Interface System Interface Networking Speeds Supported Cabling

1Gb LC Fiber 850 nm

PCIeG2 x1, Half Height, Half Length

1000Base-X (1Gbps)

50/125 µm (core/cladding) multimode fiber optic cable up to 500m 62.5/125 µm (core/cladding) multimode fiber optic cable up to 220m

Power Consumption (active-typical)

Physical Dimensions Connect Speed LED Indicators

Operating Temperature Hardware Certifications 1.5 Watts

8.8 cm x 6.9 cm (3.5 in x 2.7 in) ON: 1Gbps Link OFF: Link down

-25°C to 70°C (-13°F to 158°F)

IEEE 802.1p (Quality of Service), IEEE 802.1Q (VLANs), IEEE 802.2 (LLC), IEEE 802.3ac (MAC), IEEE 802.3x (Flow control auto-negotiation), IEEE

802.3z (1000 Base-X), IEEE 802.3ad (Link aggregation)

RoHS, UL, FCC/EN55022 Class A, TUV, EN55024, CE, C-TICK, VCCI

Intel® X710-DA2 **10GBASE-SR Converged Network Adapter**

Networking Interface System Interface

Networking Speeds

Supported Cabling

2 SFP+ Ports for LC SFP+ Transceivers

1Gbps, 10Gbps

Power Consumption (active-typical)

Physical Dimensions Connect Speed LED

Indicators

PCI Express 3.0 x8

LC fiber optic cabling with LC SFP+ Transceivers

6.578 in x 2.703 in

Link/Activity LED Off = No link

Blinking = Activity

Speed LED

4.3W

Off = 10Mbps

Green = 100Mbps

Amber = 1Gbps

Operating Temperature 0 °C to 55 °C (32 °F to 131 °F)

Technical Specifications - Networking and Communications

Hardware Certifications USA: FCC B,

EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Note: Windows 7 is NOT supported

10GbE SFP+ SR Transceiver **Connector Type** LC

Cable Type 62.5/125um or 50/125um (core/cladding), graded-index, low metal

content, multimode fiber optic, complying with ITU-T G.651 and ISO/IEC

793-2 Type A1b or A1a, respectively.

Cable Length2-300mWavelength850nmForm FactorSFP+

Physical Dimensions 0.47(h) x 0.54(w) x 2.19(d) inches

(1.19 x 1.38 x 5.57 cm)

Operating Temperature OC to 45C (32F to 113F) **Operating Humidity** 0% to 85%, noncondensing

Intel® 8265 WLAN

Networking Speeds 802.11ac MU-MIMO (up to 867 Mbps)

Bluetooth 4.2

IEEE WLAN Standard IEEE 802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w;

802.11r, 802.11k, 802.11v pending

Bluetooth 4.2

System Interface PCI Express 2.1 x1

Antenna 2x2



Summary of Changes

SUMMARY OF CHANGES

Date of change:	Version History:		Description of change:
November 1, 2017	From v1 to v2	Added	HP DisplayPort to HDMI Adapter, NVIDIA SLI 2-slot Graphics Connector and
			NVIDIA Quadro Sync II to Graphics section
		Changed	Graphics, Storage / Hard Drives and Memory sections, changed Front and
			internal view info on the Overview section, changed Operating Systems
			section, changed System Board section, changed System Configuration,
			DECLARED NOISE EMISSIONS and Physical Security and Serviceability
			sections
November 29, 2017	From v2 to v3	Added	Processors, hard drives and graphics to offerings, added Intel Xeon W-2195
			to Processors section
		Changed	Wattage links on power supply section updated and Voltage links on
			efficientcy section updated
February 5, 2018	From v3 to v4	Added	Features and Supported Configurations for Intel® Core™ X- Series
		Cl	Processor Family
Fab	F.,	Changed	Formatting
February 27, 2018 March 27, 2018	From v4 to v5	Added	Intel Core i9-X processors footnotes added to processors pre-installed
	From uE to uE	Added	section NVIDIA Quadro GP100 16GB Graphics, NVIDIA Quadro GV100 32GB Graphics
	From v5 to v6	Added	and AMD Radeon Pro WX 9100 16GB Graphics as High End 3D in Graphics
			section
August 13, 2018	From v6 to v7	Added	Footnote to Networking and Communications section
	110111 00 10 07	Changed	Operating Systems section
August 24, 2018	From v7 to v8	Changed	Format
September 21, 2018	From v8 to v9	Added	Intel Optane SSD 905p AiC 280GB & 480GB
September 26, 2018	From v9 to v10	Changed	NVIDIA Quadro P6000 Graphics specs
February 11, 2019	From v10 to v11	Added	NVIDIA Quadro RTX 5000 16GB and NVIDIA Quadro RTX 6000 24GB
Cordary 11, 2015	110111111010111	ridaca	Graphics, added Intel Core i9-9980XE, Intel Core i9-9920X, Intel Core i9-
			9820X and Intel Core i7-9800X processors
		Changed	Storage section and Format changes
May 8, 2019	From v11 to v12	Changed	Storage and Graphics sections
June 12, 2019	From v12 to v13	Changed	Storage section
June 24, 2019	From v13 to v14	Changed	RAID Support
July 15, 2019	From v14 to v15	Changed	Corrected Intel 905p Series AIC 480GB PCIe SSD
July 18, 2019	From v15 to v16	Changed	HP SD 4 Card Reader part number
July 23, 2019	From v16 to v17	Changed	Windows 10 Pro High End added to Processors and under Intel Core X-
			series Processors Preinstalled
			Power supply-high end section re-arranged
September 1, 2019	From v17 to v18	Added	Footnote to Memory section, Added HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4
			SSD Kit & module to Storage section, Added Intel® Wi-Fi 6 AX200 & BT PCIe
			to Networking section
October 26, 2019	From v18 to v19	Changed	Graphics section
November 1, 2019	From v19 to v20	Added	HP QX310 Removable NVMe Frame/Carrier w/PCIe card to Optical and
			Removable Storage section
December 5, 2019	From v20 to v21	Added	Intel Xeon W-2200, Intel Core i9-10900X X-series processors and added
			new HP Z4 G4 Memory Cooling Solution on Other Hardware section
		Changed	Storage / Hard Drives, Memory and System Board sections
January 2, 2020	From v21 to v22	Changed	Front I/O and Rear I/O Overview subsections and changed Storage section
February 6, 2020	From v22 to v23	Changed	Storage / Hard Drives, Optical and Removable Storage and Physical Security
			and Serviceability
June 5, 2020	From v23 to v24	Added	AMD Radeon Pro W5500 and AMD Radeon Pro W5700 to Graphics section
		Changed	HARD DRIVE CONTROLLERS section



Summary of Changes

January 5, 2021	From v24 to v25	Changed	Processors, Memory, Graphics, Racking and Physical Security, Operating
January 7, 2021	From v25 to v26	Changed	Systems and Hard Drives sections Hard Drives section
February 1, 2021	From v26 to v27	Changed	NETWORKING AND COMMUNICATIONS section
March 1, 2021	From v27 to v28	Changed	Overview and Memory sections
April 13, 2021	From v28 to v29	Changed	Graphics, Social and Environmental Responsibility sections
April 21, 2021	From v29 to v30	Changed	Memory section
May 1, 2021	From v30 to v31	Changed	Graphics and Software sections
June 1, 2021	From v31 to v32	Changed	Memory section
July 1, 2021	From v32 to v33	Changed	Graphics section
July 16, 2021	From v33 to v34	Changed	Racking and Physical Security section
August 1, 2021	From v34 to v35	Changed	Graphics section
September 1, 2021	From v35 to v36	Changed	Input Devices, Graphics and Memory sections
October 1, 2021	From v36 to v37	Changed	Processor Matrix, Graphics and System Board sections
December 1, 2021	From v37 to v38	Changed	Operating Systems, Graphics, Networking and Communications and Input Devices sections
December 15, 2021	From v38 to v39	Changed	OPERATING SYSTEM and Social and Environmental Responsibility sections
January 1, 2022	From v39 to v40	Changed	Graphics, OPERATING SYSTEM and Application Software sections
February 1, 2022	From v40 to v41	Changed	Input Devices section
March 1, 2022	From v41 to v42	Changed	Graphics, Social and Environmental Responsibility sections
April 1, 2022	From v42 to v43	Changed	Processors, Graphics and Stable & Consistent Offerings sections



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